MOBILE RADIO

MAINTENANCE MANUAL

MONITOR RECEIVERS TYPE ER-51-A & ER-52-A

(Note: The UHF Monitor Receiver Type ER-53-A is covered in LBI-4039)



SPECIFICATIONS * 132-174 MHz 25-50 MHz ER-51-A ER-52-A Receiver Type 20 kHz (Narrow Band) 30 kHz (Narrow Band) Channel Spacing Sensitivity 12-dB SINAD 0.25 μV 0.3 μV 0.35 µV 20-dB Quieting 0.5 µV Selectivity (EIA Two-Signal Method) -60 dB -80 dB Spurious Response -75 dB -65 dB -55 dB -55 dB Intermodulation (EIA) $\pm.002\%$ (-30°C to +60°C, $\pm.001\%$ (-30°C to +60°C, First Oscillator Stability $+25^{\circ}C$ reference) +25°C reference) ±6 kHz ±7 kHz Modulation Acceptance Squelch Sensitivity 0.15 μV minimum 0.2 µV minimum 1.0 μV maximum 1.0 μV maximum Within +2 dB and -8 dB of a 6 dB/octave Frequency Response de-emphasis curve from 300 to 3000 Hz (1000 Hz reference) per EIA standards **Operable Temperature Range** -30° C to $+60^{\circ}$ C (-22° F to $+140^{\circ}$ F) Audio Output 1.5 watts at less than 10% distortion Power Input 20 watts at 117 VAC ±10%, 50/60 Hz 0.4% Maximum Frequency Separation

Maintenance Manual LBI-37576

ER-51-A & ER-52-A

These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.



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WARNING -

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS.

EQUIPMENT INDEX

EQUIPMENT	MODEL OR TYPE NUMBER
25-50 MHz Receiver	ER-51-A
132-174 MHz Receiver	ER-52-A
Front Panel	19D402678-G1
Chassis	19C311011-G1
Top Cover	19A122161-G2
Standby Battery Supply	19B205435-G2
Channel Guard Decoder	4EK15A10
Bottom Cover (Support)	19B205283-G2

OPTIONAL EQUIPMENT

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Type 99 Tone Decoder Boards A1403 & A1404 (One thru four boards, Options 4203 thru 4206)	 19D413100-G1
Type 90 Tone Decoder Board A1701 (One thru four boards, Options 4207 thru 4210)	19C303730-G1
Audible Alarm, Option 4211 Buzzer and Second Relay	7136597-G2
Antenna Adaptor Cable, Option 4212	19A122312-G1
Carrier Operated Relay, Option 7610	19C303533-G2
132-174 MHz Indoor Antenna Option 4213 (Includes Connector M2R22-P2)	4EY19C10
Improved Intermodulation Modification, Option 5495	19A127250-G1

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8th & 9th Digit	=	25-33 MHz	0	33-42 MHz	88	42-50 MHz	10 10	132-150.8 MHz	88	150.8-174 MHz
7th Digit	Ŋ	Standard	C	Channel Guard		· ·				·
6th Digit	٩	l-Freq.	۵	2-Freq.						
5th Digit	Σ	117-VAC	Z	117-VAC and Stby Battery						
4th Digit	4	20 kHz Channels	6	30 kHz Channels						
3rd Digit	0	Standard	N.	Two reeds Type 99	4	Four reeds Type 99				
2nd Digit	n	Standard	۵	Type 99 Decoder	Þ	Type 90 Decoder				
lst Digit	Z	Monitor Rcvr					_			

Figure 1 - Combination Nomenclature Chart

DESCRIPTION

General Electric Monitor Receivers are attractively styled, high performance FM receivers designed for operation in the 25--50 and 132-174 megahertz range. The receivers are fully transistorized -- utilizing silicon transistors for added reliability. The compact design of the units permits them to be easily mounted on a desk, shelf or table with room left over for books, papers, etc.

Optional decoder boards are available for use with the receiver so that the unit will operate in a two-way radio system employing Channel Guard, Type 90 and Type 99 Encoders.

The receiver normally operates from a 117 volt AC, 50/60 Hz source. An optional chassis-mounted standby battery supply is available to power the receiver for up to seven hours in the event of power failure. The receiver may also be operated from an external 12-volt battery if desired.

Combination numbers for the receiver are shown in the Combination Nomenclature Chart (Figure 1.)

OPERATION

RECEIVER

Operating controls for the Monitor Receiver include the VOLUME and SQUELCH controls located on the front panel, and an OFF-ON switch located at the rear of the unit.

Turn the receiver on by sliding the OFF-ON switch to the ON position. The green power-on light will glow when the power is on. Then turn the SQUELCH control all the way to the right. If the receiver is equipped with Channel Guard, Type 90 or Type 99 Tone Decoders, disable the decoder circuitry by placing the RESET-MONITOR switch in the MONITOR position. Always return the MONITOR switch to the center position after making all adjustments.

Adjust the VOLUME control until the hissing sound is easily heard but not annoyingly loud. Next, turn the SQUELCH control slowly to the left until the hissing sound just fades out.

In two-frequency receivers, select the proper frequency (F1 or F2). The receiver is now ready to monitor two-way radios in the system.

CHANNEL GUARD

The operating control for the Channel Guard Decoder consists of a RESET-MONITOR switch located on the front panel. The decoder keeps all signals on the channel locked out of the Monitor Receiver except those that are continuously tone coded for positive identification by the decoder.

When a signal that is modulated by the proper tone code is received, the receiver audio circuits operate. Placing the RESET-MONITOR switch in the MONITOR position disables the Channel Guard Decoder, and permits all calls on the channel to be heard.

TYPE 90 & TYPE 99 TONE DECODERS

Operating controls for the Type 90 and Type 99 Tone Decoders include a RESET-MONI-TOR switch and an amber Call light located on the front panel.

When a properly tone-coded signal is received, the Call lamp lights and the message is heard in the speaker. After the message is completed, momentarily placing the RESET-MONITOR switch in the RESET position re-activates the decoder circuitry.

Placing the switch in the MONITOR position disables the decoder circuitry and permits all calls on the channel to be heard. Always return the RESET-MONITOR switch to the center position after monitoring the channel so that the receiver will operate normally.

CIRCUIT ANALYSIS

RECEIVER

Receiver Types ER-51-A (25-50 MHz) and ER-52-A (132-174 MHz) are double conversion, superheterodyne receivers designed for operation with the General Electric Monitor Receiver.

Each receiver consists of a receiver board and a lst oscillator board. The frequency ranges and number of frequencies for the receivers are shown in the following chart.

RECEIVER TYPE NO.	RECEIVER BOARD	1ST OSCILLATOR BOARD	FREQUENCY RANGE	NUMBER OF FREQUENCIES
ER-51-A	19D402429-G1 19D402429-G1 19D402429-G2 19D402429-G2 19D402429-G2 19D402429-G3 19D402429-G3	4EG19A10 4EG19A11 4EG19A10 4EG19A11 4EG19A10 4EG19A11	25-33 MHz 25-33 MHz 33-42 MHz 33-42 MHz 42-50 MHz 42-50 MHz	One Frequency Two Frequency One Frequency Two Frequency One Frequency Two Frequency
ER-52-A	19D402257-G1 19D402257-G1 19D402257-G1 19D402257-G1 19D402257-G1	4EG20A10 4EG20A11 4EG20A12 4EG20A13	132-150.8 MHz 132-150.8 MHz 150.8-174 MHz 150.8-174 MHz	One Frequency Two Frequency One Frequency Two Frequency

The audio PA stage is mounted on the main chassis, and the loud-speaker is mounted on the front panel. The unit is completely transistorized -- utilizing 17 silicon transistors, seven silicon diodes and two zener diodes. An additional transistor is added for two-frequency operation.

A centralized metering jack (J312) is provided for use with General Electric Test Set TM11 or TM12 (Model 4EX3A10) for aligning and servicing the receiver. The Test Set meters the limiter stages, oscillator, supply voltages, voice coil, PA and discriminator stages.

VOLTAGE REGULATOR

The receiver operates on a regulated 10 volts provided by Q315 and Q316 in a series regulator circuit.

When the input voltage at J311 starts to rise, the output voltage at the emitter of Q315 also tries to rise. This changes the base-emitter bias on Q316, causing it to conduct more heavily. When Q316 conducts, there is less base bias on Q315 and, therefore, less base current flows through the transistor. With less base current flowing, the voltage drop across Q315 is larger and less voltage appears at the output.

When the input voltage starts to drop, Q316 conducts less, increasing the forward bias on Q315. The increased forward bias decreases the voltage drop across Q315, and more voltage appears at the output. Regulation will stop if the input value drops below 11 volts.

The 10-volt REGULATOR adjustment (R372/R373) is set for a 10-volt reading at centralized metering jack J312 when aligning the receiver.

RF AMPLIFIER

RF signals from the antenna are fed to the base of low noise RF amplifier Q301 through two tuned pre-selector circuits. The output of the RF amplifier is coupled through two tuned circuits to the base of the 1st mixer.

OSCILLATOR/MULTIPLIER

In 25-50 MHz receivers, Q425 is a Colpitts oscillator operating in the 12 to 19 megahertz range. Trimmer capacitor C425 permits the oscillator frequency to be shifted slightly for setting the receiver on the system operating frequency.

For 25 to 33 megahertz operation, collector coil L425 is tuned to two times the crystal frequency with high-side injection. For 33 to 42 megahertz operation, L425 is tuned to two times the crystal frequency with low-side injection. For 42 to 50 megahertz operation, L425 is tuned to three times the crystal frequency with lowside injection.

In 132-174 MHz receivers, Q425 is a third mode oscillator that operates in the 49 to 54 megahertz region. The crystal is connected in the oscillator feedback path to permit oscillation only at the crystal frequency. L425, C425, C426 and C428 make up the mode selective resonant circuit. Adjustable coil L425 permits the oscillator frequency to be shifted slightly for setting the receiver on the system operating frequency. The collector tank of A425 is tuned to three times the crystal frequency.

For two-frequency operation, a second oscillator/multiplier stage is added. Channels are selected by grounding the emitter of the desired oscillator by means of a two-frequency switch on the front panel.

1ST MIXER

RF signals from the RF amplifier are fed to the base of 1st Mixer Q302 along with the oscillator injection frequency. The Hi IF mixer output is fed to a threecoil torroidal Hi IF filter and then fed to the base of 2nd mixer Q304.

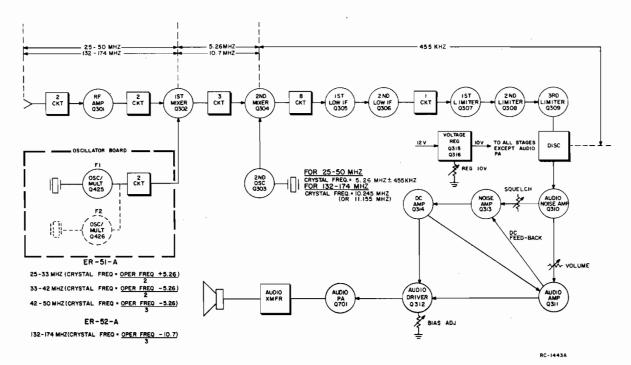


Figure 2 - Receiver Block Diagram

2ND OSCILLATOR AND MIXER

Q303 operates as a Pierce oscillator with a crystal frequency of 3.26 megahertz ± 455 kHz for low band or 10.245 (or 11.155) megahertz for high band.

Hi IF from the 1st mixer is applied to the base of 2nd mixer Q304. This Hi IF is mixed with the 2nd oscillator low side (or high side) injection frequency which produces the 455-kilohertz Lo IF. The main receiver selectivity is provided by the eight-coil Lo IF filter following the 2nd mixer.

LO IF AMPLIFIERS

Two RC-coupled Lo IF amplifiers (Q305 and Q306) are used to amplify the signal going to the limiter stages. The amplifier output is coupled to the 1st limiter through a 455-kHz filter (L316 and C348), which reduces the noise bandwidth of the IF string.

LIMITERS

Following the Low IF amplifiers are three RC-coupled limiter stages, Q307, Q308 and Q309, which operate as over-driven amplifiers. Zener diode CR308 provides additional limiting. The 1st and 2nd limiter stages are metered at the centralized metering jack (J312) through metering diodes CR301 and CR302.

DISCRIMINATOR

The limiter output is applied to the Foster-Seely type discriminator, where the audio voltages are recovered from the 455kHz Lo IF. A Lo IF filter removes any 455kHz signal remaining in the discriminator output.

AUDIO AMPLIFIERS

When audio is present in the incoming signal, it is fed to the base of audionoise amplifier Q310. Following Q310 is an audio de-emphasis network.

After the de-emphasis network, audio is fed to the base of audio amplifier Q311 through the volume control mounted on the front panel. The VOLUME control sets the amount of drive to the audio stages. An audio driver (Q312) and an audio PA output stage (Q701) follow audio amplifier Q311. Audio Bias trimmer R366/R367 sets the bias on Q312 and Q701, and is adjusted for a 250-millivolt reading at metering jack J312. The output of Q701 drives the loudspeaker.

SQUELCH

Noise from audio-noise amplifier Q310 is used to operate the squelch circuit. When no carrier is present in the receiver, this noise is coupled through a noise filter (which attenuates any audio frequencies) to the base of noise amplifier Q313. The noise level fed to the noise amplifier is set by the SQUELCH control, located on the control unit. The output of noise amplifier Q313 is rectified by diodes CR305 and CR306, to produce a positive DC voltage. This DC voltage turns on the DC amplifier (Q314), causing it to conduct. When conducting, the collector voltage of the DC amplifier drops to ground potential, which removes the bias on the audio stages and turns them off.

When audio amplifier Q311 is being turned off, its emitter potential decreases. This results in a positive DC feedback through R351/R352 to the emitter of noise amplifier Q313 which causes an increase in the gain. As the gain of Q313 increases, the positive DC voltage to the DC amplifier increases, turning the audio stages off quickly.

When the receiver is quieted by a signal, less noise is present in the circuit and DC amplifier Q314 stays off. The audio stages are allowed to conduct and audio is heard from the speaker. With audio amplifier Q311 conducting, positive voltage appears across R351/R352 which helps reduce the gain of noise amplifier Q313. The positive feedback causes a quick, positive switching action in the squelch circuit.

POWER SUPPLY

The Monitor Receiver has a self-contained power supply designed to operate from a 117-volt AC, 50/60 Hz source. The power supply consists of a full-wave rectifier (CR701 and CR702) for rectifying the AC voltage developed across the secondary of step-down transformer T701. The primary of T701 is protected by a 1/4-amp slow-blow fuse (F701).

The output of the rectifiers is filtered by C701, L701 and C702 to provide +12 volts DC for operating the receiver, audio PA stage and the tone options.

The power-on indicator light is operated by an unfiltered +12 volts.

OPTIONS

CHANNEL GUARD DECODER

The Channel Guard decoder is designed to eliminate all calls that are not tone coded for the Channel Guard frequency. Normally, all signals are locked out except those from transmitters that are continuously tone-coded for positive identification by the receiver. Placing the Monitor switch S704 in the MONITOR position, instantly disables the Channel Guard circuit and the receiver operates on noise squelch only. For complete operating and maintenence information, refer to the Maintenance Manual for the decoder LBI-3802.

TYPE 90 AND TYPE 99 DECODERS

A maximum of four tone decoder boards with single relays or two decoder boards with two relays can be used with the Monitor Receiver.

The basic decoder board is supplied with one output relay. When a signal modu-lated by a pulse tone (Type 90) or sequential tone (Type 99) is received from the receiver discriminator, the relay locks up and the Call light turns on, and the message is heard in the speaker. Placing the RESET-MONITOR switch (S703) in the RESET position unlocks the relay and cuts off the Call light. If desired, one set of relay contacts can be used to activate an external alarm. An optional second relay and buzzer is available for use with the tone decoders. A description of the option is contained in the following section. For complete, operating and maintenance information concerning the Type 90 Tone Decoder refer to LBI-3684 or for Type 99 Tone Decoder refer to LBI-3839.

AUDIBLE ALARM

An Audible Alarm, consisting of a buzzer and second relay, can be used with the Type 90 and Type 99 Decoders. The relay plugs into the socket provided on the decoder board, and the buzzer mounts on the under side of the chassis as shown on the chassis Outline Diagram.

When the Audible Alarm option is used, the output relay can be connected for timed operation (3 to 5 seconds). The second relay operates locked to the RESET switch. The buzzer operates from the timed relay.

STANDBY BATTERY SUPPLY

The Standby Battery Supply is available for providing up to seven hours of operation in the event of power failure. The Battery Supply mounts on the chassis of the Monitor Receiver, and consists of a voltage-regulated taper charging circuit, a change-over relay and two rechargeable nickel-cadmium batteries. A maximum of two Type 90 or Type 99 Tone Decoders can be mounted on the Monitor Receiver chassis when the Standby Battery Supply is used.

Turning OFF-ON switch S701 to the ON position applies 117 VAC to the primary of stepdown transformer T1, and +12 volts to energize relay K1. The AC voltage developed across the secondary of T1 is rectified by the full-wave rectifier CR1 and CR2 and filtered by R1, R2 and C1. R1 and R2 also serve as charging current limiting resistors when the two batteries, BT1 and BT2, are in a discharged condition.

Dropping resistor R4, provides the negative bias to turn on Q1. Zener diode VR1



provides a voltage reference for the regulator.

When the input voltage at H7 rises, the output voltage at the emitter of Ql also tends to rise. This causes a change in the base-emitter bias on Q2 making it conduct more heavily. When Q2 conducts, there is less base bias on Ql, and less base current. With less base current, the voltage drop across Ql is larger, and the output voltage remains constant.

When the input voltage starts to drop, the output voltage also tends to drop, causing Q2 to conduct less. This increases the forward bias of Q1 and reduces the voltage drop across the transistor so that the output voltage remains constant. R5, R6 and R7 form an adjustable voltage divider so that potentiometer R6 can be adjusted for a 16.65-volt output. R3 provides bias current for VR1. The output is metered between H5 (+) and H4 (-) with the batteries disconnected.

If the batteries BT1 and BT2 are in a discharged condition, the charging current will be at a maximum since the regulator is supplying a constant voltage. The charging current will decrease as the batteries become fully charged until finally the batteries are receiving only a trickle charge.

In the event of a power failure, the relay is de-energized and the battery output is applied through K1-11 to operate the receiver. Diode CR2 prevents the pilot light (DS701) from lighting. Resistor R2 is switched in series with the emitter resistor of the audio PA stage (Q701), which reduces the audio output to approximately 150 milliwatts. When fully charged, the batteries will operate the receiver for approximately seven hours on a 10% receive, 90% squelched duty cycle.

CARRIER OPERATED RELAY

The Carrier Operated Relay assembly provides four form C contacts for controlling external circuits whenever a carrier is applied to the receiver.

When a carrier unsquelches the receiver, a positive voltage (approximately 2 volts) from the base of the receiver audio amplifier transistor turns on Ql in the carrier operated relay circuit. Current flow in the collector circuit of Ql forward biases Q2, causing it to conduct and energize relay KL. Voltage "spikes" produced across Kl (when Kl deenergizes) are absorbed by diode CR1 to prevent damage to transistors Ql & Q2.

IMPROVED INTERMODULATION

The Improved Intermodulation modification is available for use with 132-174 MHz receivers to provide a 60 dB intermodulation response (EIA) with some loss in receive sensitivity. The modification consists of replacing the RF Amplifier circuit in the receiver front end with trimmer C2351 (see Figure 3).

Trimmer C2351 permits tuning the receiver to trade off sensitivity for improved intermodulation protection. The trimmer can be tuned for a 20 dB quieting sensitivity of 0.8 to 1.5 microvolts (0.6 to 1.2 microvolts for 12 dB SINAD). Instructions for adjusting C2351 are contained on the Receiver Alignment Procedure (see Table of Contents).

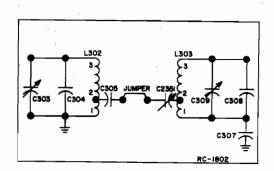


Figure 3 Improved Intermodulation Modification

ADJUSTMENT

RECEIVER

After the Monitor Receiver has been installed, the receiver should be set on the system operating frequency, and the antenna transformer matched to the antenna. Refer to the Front End Alignment on the RECEIVER ALIGNMENT PROCEDURE as listed in the Table of Contents.

DECODERS

No adjustments are required on the Channel Guard, Type 90 or Type 99 Decoders.

STANDBY BATTERY SUPPLY

Potentiometer R6 is adjusted and secured with a sealant at the factory to prevent tampering. However, if either VR1 or Q2 is replaced, it is recommended that R6 be replaced to facilitate adjustment. If it becomes necessary to adjust R6 and no replacement part is available, the sealant may be loosened by heating the metal ring on R6 with a soldering iron while making

ADJUSTMENT

the adjustment. This procedure requires a DC-VTVM that is accurate to $\pm .02$ volts.

SET R6 AS FOLLOWS:

- 1. Disconnect BT1 and BT2.
- 2. Connect the positive meter lead to the positive charging terminal (H5) and the negative meter lead to the negative charging terminal (H4) on the standby battery supply board.
- 3. Turn on switch S701 and adjust R6 for a voltage reading of 16.65 volts.
- 4. Turn off switch S701 and secure R6 with cement (Loctite R404 or equivalent).

MAINTENANCE

TEST AND TROUBLESHOOTING PROCEDURES

Whenever difficult servicing problems

occur, the test procedure for the receiver can be used by the serviceman to compare actual performance of the unit against the specifications met by the unit when shipped from the factory. The Test Procedure is described on the back of the Receiver Alignment Procedure.

In addition, a Receiver Troubleshooting Procedure is available. (Refer to the Table of Contents). For best results, the test procedure should be used in conjunction with the troubleshooting procedure.

Refer to the applicable Maintenance Manual for servicing the Type 90 or Type 99 Tone Decoders.

DISASSEMBLY

To gain access to the Monitor Receiver for servicing, loosen the two captive knurled screws in the back of the unit and lift off the top cover.

- NOTE -

If it should become necessary to replace the audio PA transistor (Q701), make sure that there is a thin layer of silicon grease on each side of the insulator before remounting the transistor.

FRONT END ALIGNMENT

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These instructions are for tuning the oscillator and RF stages of the receiver and may be used when changing the receiver crystal or frequency. When necessary to realign the entire receiver, refer to the COMPLETE RECEIVER ALIGNMENT.

EQUIPMENT REQUIRED

- 1. G-E Test Set Model TM11 or TM12 (or 20,000 ohms-per-volt Multimeter).
- 2. A 25-50 mHz Signal Source. Keep signal level below saturation.

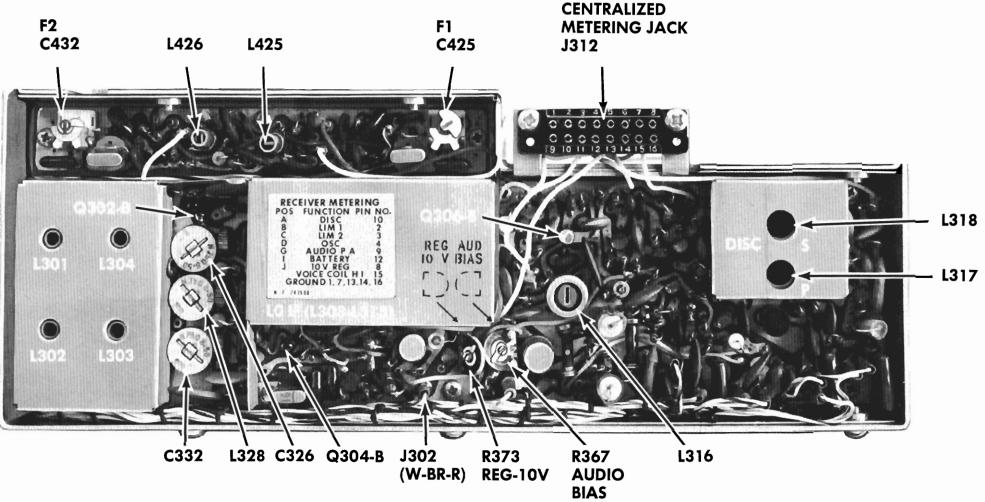
PRELIMINARY CHECKS AND ADJUSTMENTS

- 1. Plug in the Test Set to the receiver centralized metering jack J312. Set Meter Polarity Switch on + and Meter Sensitivity Switch to 1. If using Multimeter, connect the negative lead to J312-13 (ground).
- 2. Switch Test Set to Position "I" (or measure at J302 with Multimeter). Reading should be at least 12 volts.
- Switch to Position "J" (or measure across R373 with Multimeter) and adjust Voltage Regulation Potentiometer R373 for a reading of 10 volts.
- 4. Turn SQUELCH control fully clockwise and VOLUME control to minimum. Switch to Position "G" (or measure at J312-9 with Multimeter) and adjust Audio Bias Potentiometer R367 to a reading of 0.25 volt.

ALIGNMENT PROCEDURE

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		METERIN	G POSITION			
	STEP	4EX3A10	Multimeter + at J312	TUNING CONTROL	METER READING	PROCEDURE
a service of the design	1.	D OSC	Pin 4	C425 (and C432 for two-fre- quency), L425 and L426	See Proce- dure	Tune C425 (and C432 for two-frequency) and L425 for maxi- mum meter reading. Then tune L426 for minimum meter read- ing. NOTE Start tuning proce- dure with the slugs fully in on 25-42 mHz units and fully out on 42-50 mHz units.
	2.	C LIM-2	Pin 3	L301 thru L304	Maximum	Apply an on-fre- quency signal to An- tenna Jack and tune L301 through L304 for maximum meter reading.
	3.			L301 and L302	See Proce- dure	While receiving a weak on-frequency signal at the An- tenna, tune L301 and L302 for maxi- mum quieting.
	4.	A DISC	Pin 10	C425 (and C432 for two-fre- quency)	Zero	Apply an on-fre- quency signal to An- tenna Jack and tune C425 (and C432 for two-frequency) for zero discriminator reading.



EQUIPMENT REQUIRED

COMPLETE RECEIVER ALIGNMENT

- 1. G-E Test Set Model TM11 or TM12 (or 20,000 ohms-per-volt Multimeter).
- A 455 kHz , a 5.26 mHz and a 25-50 mHz Signal Source. Couple the 455 kHz signal through a small capacitor (approximately 100 pf). Couple the 5.26 mHz signal through a .01 μf capacitor. Keep signal levels below saturation.

PRELIMINARY CHECKS AND ADJUSTMENTS

- Plug in the Test Set to the receiver centralized metering jack J312. Set Meter Polarity Switch on + and Meter Sensitivity Switch to TEST 1. If using Multimeter, connect the negative lead to J312-13 (ground).
- 2. Switch Teist Set to Position "I" (or measure at J302 with Multimeter). Reading should be at least 12 volts.
- 3. Switch to Position "J" (or measure across R373 with Multimeter) and adjust Voltage Regulation Potentiometer R373 for a reading of 10 volts.
- Turn SQUE)LCH control fully clockwise and VOLUME control to minimum. Switch to Position "G" (or measure at J312-9 with Multimeter) and adjust Augino Bias Potentiometer R367 for a reading of 0.25 volt.

ALIGNMENT PROCEDURE

STEP	METERINO TEST SET 4EX3A10	G POSITION MULTIMETER + at J312	TUNING CONTROL	METER READING	PROCEDURE		
				DISCRIMI			
1							
1.	C LIM-2	Pin 3		0.3 volt (1.1 v with Multimeter)	Apply a 455 kHz signal to the base of Q306 and adjust signal level for 0.3 volt meter reading (to saturate limiters).		
2.	A DI SC	Pin 10	L318	Zero	Apply a 455 kHz signal as above and adjust L318 (disc secondary) for zero meter reading.		
3.	A DISC	Pin 10	L317 & L318	0.65 v (1.6 v with Multimeter)	Alternately apply a 445 kHz and 465 kHz signal while adjusting L317 and L318 for readings of at least 0.65 volt. Both readings should be within 10%.		
4.	B LIM-1	Pin 2	L316	Maximum	Apply a 455 kHz signal as above, and tune L316 for maximum meter reading.		
5.	D OSC	Pin 4	C425 (and C432 for two frequency) L425 and L426	See Procedure	Tune C425 (and C432 for two-frequency) and L425 for maximum meter reading. Then tune L426 for minimum meter reading. NOTE Start tuning procedure with the slugs fully in on 25-42 mHz units and fully out on 42-50 mHz units.		
				ні і	F		
6.	C LIM-2	Pin 3	C326, C328 and C332	Maximum	Apply a 5.26 signal to the base of Q302 or an <u>on-frequency</u> signal to Antenna Jack J701. Turn C326, C328 and C332 for maximum meter reading.		
				LOW	IF*		
7.	A DISC	Pin 10		Zero	Apply a 5.26 mHz signal to the base of Q304. Adjust the signal generator for discriminator zero.		
8.	C LIM-2	Pin 3	L308 thru L315	Maximum	Apply signal as above. Peak L308 through L315 for maximum meter reading, keeping signal below saturation.		
9.			L308 thru L315		Connect oscilloscope to Pin 2 and Pin 13 (Ground) to centralized metering jack J312. Modulate signal generator with at least ± 30 kl deviation with 60 Hertz (or less). Tune L308 through L315 for filter pattern as shown, keeping signal level below saturation. The above filter alignment should result in the center of the bandpass at 455 kHz ± 1 kHz (± 0.7 volt reading with meter in Position A), with a EIA modulation acceptance of ± 6 to ± 10 kHz.		
	1	1		RF			
10.	C LIM-2	Pin 3	L301 thru L304	Maximum	Apply an on-frequency signal to Antenna Jack and tune L301 through L304 for maximum meter reading.		
11.	~		L301 and L302	See Procedure	While receiving a weak on-frequency signal at the Antenna, tune L301 and L302 for maximum quieting.		
				FREQUENCY A	DJUSTMENT		
12.	A DISC	Pin 10	C425 (and C432 for two-frequency)	Zero	Apply an on-frequency signal to Antenna Jack and tune C425 (and C432 for two-frequency) for zero discriminator reading. NOTE For proper frequency control of the receiver, it is recommended that all frequency adjustments be made when the equipment is at a temperature of approximately 75°F. In no case should frequency adjustments be made when the equipment is outside the temperature range of 50° to 90°F.		

* NOTE — Low IF coils L308 through L315 have been set at the factory and will normally require no further adjustment. Do NOT realign the filter unless there is positive evidence of a defective filter. For location of IF coils, refer to the Receiver Service Sheet.

LBI-3757

ALIGNMENT PROCEDURE

25-50 MHz RECEIVER TYPE ER-51-A

(RC - 1475B)

7

LBI-3757

RECEIVER TEST PROCEDURES

a receiver that is operating — but not properly. The problems encountered could be low power, poor sensitivity, distortion, limiter not operating properly, and low gain. By following the sequence of test steps starting with Step 1, the defect can be quickly localized. Once operating frequency.

The Receiver Test Procedures are designed to help you to service the defective stage is pin-pointed, refer to the "Service Check" listed to correct the problem. Additional corrective measures are included in the Troubleshooting Procedure. Before starting with the Receiver Test Procedures, be sure the receiver is tuned and aligned to the proper

TEST EQUIPMENT REQUIRED

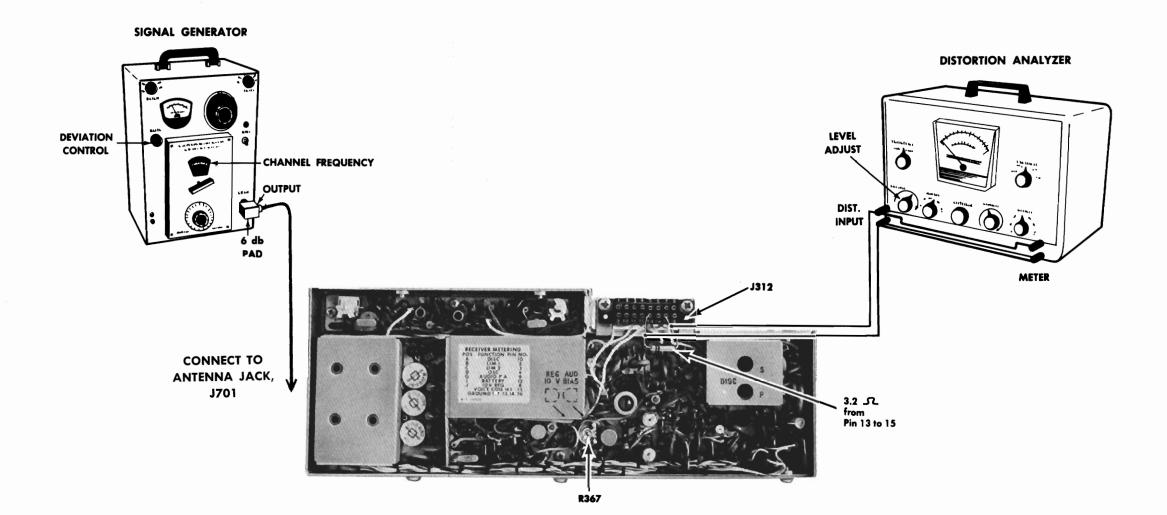
for test hookup shown:

1. Distortion Analyzer similar to: Heath #IM-12

2. Signal Generator similar to: Measurements #M-560

3. 6 db attenuation pad

The test equipment is hooked to the receiver as shown for all Receiver Test Procedures.



STEP 1

AUDIO POWER OUTPUT AND DISTORTION

TEST PROCEDURE

Measure Audio Power Output as follows:

- 1. Connect a 1,000-microvolt test signal modulated by 1,000 Hertz ± 3.0 kHz deviation to the antenna jack.
- 2. Disconnect the W-BL-O Speaker Hi lead from LS 701-2. Hook up a 3.2 ohm load resistor from Speaker Hi to ground as shown.
- 3. Connect Distortion Analyzer input across the 3.2-ohm resistor.
- 4. For standard receivers set VOLUME Control for one-watt output (1.79 VRMS).

VOLTMETER SCALE ON DISTORTION ANALYZER



ONE WATT

5. Make distortion measurements according to manufacturer's instructions. Reading should be less than 10% (5% is typical).

SERVICE CHECK

If the distortion is more than 10%, or maximum audio output is less than one watt, make the following checks:

- 1. Battery and regulator voltage—low voltage will cause distortion. (Refer to the Receiver Schematic Diagram for voltages.)
- 2. Audio Bias Adjust (R367)—low current will cause distortion.
- 3. Audio Gain (Refer to Step 2A and 2B of Receiver Troubleshooting Procedure.
- 4. Discriminator Alignment (Refer to Receiver Alignment on reverse side of page).

STEP 2

USABLE SENSITIVITY (12 db SINAD)

TEST PROCEDURE

Measure sensitivity of the receiver modulated at the standard test modulation as follows:

- 1. Be sure Test Step 1 checks out properly.
- 2. Reduce the Signal Generator output from setting in TEST STEP 1.
- 3. Adjust Distortion Analyzer LEVEL control for a + 2 db reading.
- 4. Set CONTROL for LEVEL to DISTORTION reading. Repeat Steps 1, 2, and 3 until difference in reading is 12 db (+2 db to -10 db).
- 5. The 12-db difference (Signal plus Noise And Distortion to noise plus distortion ratio) is the "usable" sensitivity level. Reading should be less than 0.3 microvolts with audio output at least $\frac{1}{2}$ watt (1.25 volts RMS across the 3.2-ohm receiver load).

VOLTMETER SCALE ON DISTORTION ANALYZER



SERVICE CHECK

If the sensitivity level is more than 0.3 microvolts, make the following checks:

- 1. Alignment of RF stages (Refer to RF Alignment in Receiver Align ment on reverse side of page).
- 2. Gain measurements as shown on the Receiver Troubleshooting Procedure.

STEP 3

MODULATION ACCEPTANCE BAND-WIDTH (IF BANDWIDTH)

TEST PROCEDURE

- 1. Be sure TEST STEPS 1 and 2 check out properly.
- 2. Set Signal Generator output for twice the microvolt reading obtained in TEST STEP 2 - 4.
- 3. Increase Signal Generator frequency deviation.
- 4. Adjust LEVEL Control for -- 2 db.

DB SCALE ON DISTORTION ANALYZER



5. Set CONTROL for LEVEL to DISTORTION reading. Repeat Steps 3. 4. and 5 until difference between readings becomes 12 db from +2 db to -10 db).

> LEVEL DISTORTION ON DISTORTION ANALYZER



6. Deviation control reading for the 12-db difference is the Modulation Acceptance Bandwidth of the receiver. It should be more than + 6 kHz (typical value is +9 kHz).

SERVICE CHECK

If the Modulation Acceptance Bandwidth test does not indicate the proper width, check the following:

- 1. Make gain measurements as shown on the Receiver Troubleshooting Procedure.
- 2. Voltage reading of 2nd Limiter (Q308) should read 0.4 volts RMS with a one-microvolt input signal on Test Set Meter or 0.9 volts with voltmeter. (Measure at J312-3),
- 3. DO NOT RE-ALIGN factory adjusted filters (L308 through L315), unless positive evidence of a defective filter is ascertained. (Refer to Filter Alignment on the Receiver Alignment Procedure.)

FRONT END ALIGNMENT

These instructions are for tuning the oscillator and RF stages of the receiver and may be used when changing the receiver crystal or frequency. When necessary to realign the entire receiver, refer to the COMPLETE RECEIVER ALIGNMENT.

EQUIPMENT REQUIRED

- 1. G-E Test Set TM11 or TM12 (or 20,000 ohms-per-volt Multimeter).
- 2. A 130-174 mHz Signal Source. Keep signal level below saturation.

PRELIMINARY CHECKS AND ADJUSTMENTS

- 1. Plug in the Test Set to the receiver centralized metering jack J312. Set Meter Polarity Switch on + and Meter Sensi-tivity Switch to 1. If using Multimeter, connect the negative lead to J312-13 (ground).
- 2. Switch Test Set to Position "I" (or measure at J302 with Multimeter). Reading should be at least 12 volts.
- 3. Switch to Position "J" (or measure across R372 with Multimeter) and adjust Voltage Regulation Potentiometer R372 for a reading of 10 volts.
- 4. Turn SQUELCH control fully clockwise and VOLUME control to mini-mum. Switch to Position "G" (or measure at J312-9 with Multi-meter) and adjust PA Bias Potentiometer R366 for a reading of 0.25 volt.

ALIGNMENT PROCEDURE

	METERI	NG POSITION Multimeter	TUNING	METER	
STEP	4EX3A10	+ at J312	CONTROL	READING	PROCEDURE
1.	D OSC	Pin 4	L425 (& L428 for two-fre- quency), L426 and L427	See Pro- cedure	Tune L425 (L428 for two- frequency) and L426 for maximum meter reading. Then tune L427 for mini- mum reading.
2.	C LIM-2	Pin 3	C302, C303 C309 & C310	Maxi- mum	Apply an on-frequency signal to J301 and tune C302, C303, C309 and C310 for maximum meter reading.
3.			C302 & C303	See Pro- cedure	While receiving a weak on- frequency signal at the Antenna, tune C302 and C303 for maximum quieting.
4.	A DISC	Pin 10	L425 & L428 (two- fre- quency only)	Zero	Apply an on-frequency signal to J701 and tune L425 (and L428 for two- frequency) for zero dis- criminator reading.

IMPROVED INTERMOD ADJUSTMENT

These instructions are for tuning the RF stages of a receiver that is equipped with the Improved Intermod Option. The receiver can be tuned for best sensitivity, or tuned to trade off sensitivity for improved intermodulation protection.

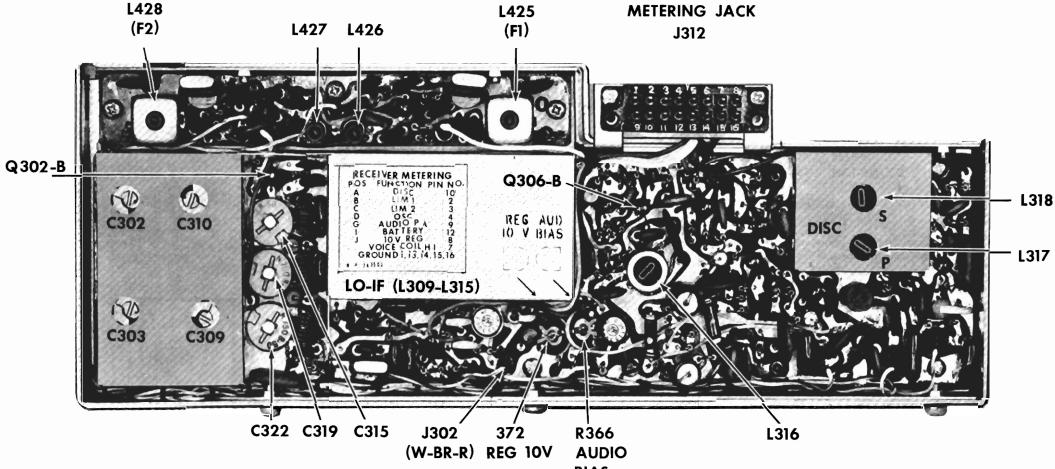
To Tune For Maximum Sensitivity:

 \sim .

- 1. Switch the GE Test Set to Position "C" (LIM-2).
- 2. Apply a weak, on-frequency signal to the antenna jack and adjust C2351 for maximum meter reading. Then adjust C3302, C303, C309 and C310 for maximum meter reading. The 20 dB quieting sensitivity should be less than 0.8 microvolt.

To Trade Off Sensitivity For Improved Intermod Protection:

- 1. Switch the GE Test Set to Position "C" (LIM-2).
- 2. Apply a weak, on-frequency signal to the antenna jack and adjust C2351 towards minimum capacity in small steps. Ad-just C302, C303, C309 and C310 for maximum meter reading each time C2351 is adjusted. Repeat this step until the desired sensitivity is obtained. The sensitivity can be adjusted for 0.8 to 1.5 microvolts.



BIAS

COMPLETE RECEIVER ALIGNMENT

EQUICPMENT REQUIRED

1. G-E Type Set TM11 or TM12 (or 20,000 ohms-per-volt Multimeter).

2. A 455 kHz, 10.7 mHz and 130-174 mHz Signal Source. Couple the 455 kHz signal through a small capacitor (approximately 100 pf). Couple the 10.7 mHz signal through a .01 µf capacitor for Hi IF, and through a 100 pf capacitor for Low IF adjustment. Keep signal levels below saturation.

PRELIMINARY CHECKS AND ADJUSTMENTS

- Plug in the Test Set to the receiver centralized metering jack J312. Set Meter Polarity Switch on + and Meter Sensitivity Switch to TEST 1. If using Multimeter, connect the negative lead to J312-13 (ground).
- 2. Switch Test Set to Position "I" (or measure at J302 with Multimeter). Reading should be at least 12 volts.
- 3. Switch to Position "J" (or measure across R372 with Multimeter) and adjust Voltage Regulation Potentiometer R372 for a reading of
- 4. Turn SQUELCH Control fully clockwise and VOLUME control to minimum. Switch to Positive "G" (or measure at J312-9 with Multimeter) and adjust PA Bias Potentiometer R366 for a reading of 0.25 volt.

ALIGNMENT PROCEDURE

STE:p	TEST SET	POSITION MULTIMETER + at J312	TUN ING CONTROL	METER READING	PROCEDURE		
				DISCRIMIN	ATOR		
1.	C LIM-2	Pin 3		0.3 volt (1.1 v with Multimeter)	Apply a 455 kHz signal to the base of Q306 and adjust signal level for 0.3 volt meter reading (to saturate limiters).		
2.	A DISC	Pin 10	L318	Zero	Apply a 455 kHz signal as above and adjust L318 (disc secondary) for zero meter reading.		
3.	A DISC	Pin 10	L317 & L318	0.65 v (1.6 v with Multimeter)	Alternately apply a 445 kHz and 465 kHz signal while adjusting L317 and L318 for readings of at least 0.65 volt. Both readings should be within 10%. Apply a 455 kHz signal as above, and tune L316 for maximum		
4.	B LIM-1	Pin 2	L316	Maximum	Apply a 455 kHz signal as above, and tune L316 for maximum meter reading.		
				OSCILLATOR AN	D MULTIPLIER		
5.	D OSC	Pin 4	L425 (and L428 for two-frequency), L426 and L427.	See Procedure	Tune L425 (L428 for two-frequency) and L426 for maximum meter reading. Then tune L427 for minimum reading.		
				HI IF			
6.	C LIM-2	Pin 3	C315, C319 and	Maximum	Apply a 10.7 kHz signal to the base of Q302 or an on-frequency signal to Antenna Jack J701. Tune C315, C319 and C322 for maximum meter reading.		
		*		LOW IF	*		
7.	A DISC	Pin 10		Zero	Apply a 10.7 mHz signal to the base of Q304. Adjust the signal generator for discriminator zero.		
8.	C LIM-2	Pin 3	L308 thru L315	Maximum	Apply signal as above. Peak L308 through L315 for maximum meter reading, keeping signal below saturation.		
9.			L308 thru L315		Connect oscilloscope to Pin 2 and Pin 13 (Ground) of centralized metering jack J312. Modulate signal generator with at least \pm 30 kHz deviation with 60 Hertz (or less). Tune L308 through L315 for filter pattern as shown, keeping signal level below saturation. The above filter alignment should result in the center of the bandpass at 455 kHz ±1 kHz (±0.7 volt reading with meter in Position A), with an EIA modulation acceptance of ±6 to ±10 kHz.		
		L		RF			
10.	C LIM-2	Pin 3	C302, C303 C309 and C310	Maximum	Apply an on-frequency signal to J701 and tune C302, C303, C309 and C310 for maximum meter reading.		
11.			C302 and C303	See Procedure	While receiving a weak on-frequency signal at the Antenna, tune C302 and C303 for maximum quieting.		
				FREQUENCY AL	JUSTMENT		
12.	A DISC	Pin 10	L425 (and L428 for two-frequency)	Zero	Apply an on-frequency signal to J701 and tune L425 (and L428 fo two-frequency) for zero discriminator reading. -NOTE For proper frequency control of the receiver, it is recommended that all frequency adjustments be made when the equipment is at a temperature of approx- mately 75°F. In no case should frequency adjustments be made when the equipment is outside the temperature range of 50° to 90°F.		

CENTRALIZED

* NOTE — Low IF coils L308 through L315 have been set at the factory and will normally require no further adjustment. Do NOT realign the filter unless there is positive evidence of a defective filter. For location of IF coils, refer to the Receiver Service Sheet.

LBI-3757

ALIGNMENT PROCEDURE

132-174 MHz RECEIVER TYPE ER-52-A

RC-1476C

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RECEIVER TEST PROCEDURES

a receiver that is operating — but not properly. The problems en- to correct the problem. Additional corrective measures are included countered could be low power, poor sensitivity, distortion, limiter not in the Troubleshooting Procedure Before starting with the Receiver operating properly, and low gain. By following the sequence of test Test Procedures, be sure the receiver is tuned and aligned to the proper steps starting with Step 1, the defect can be guickly localized. Once operating frequency.

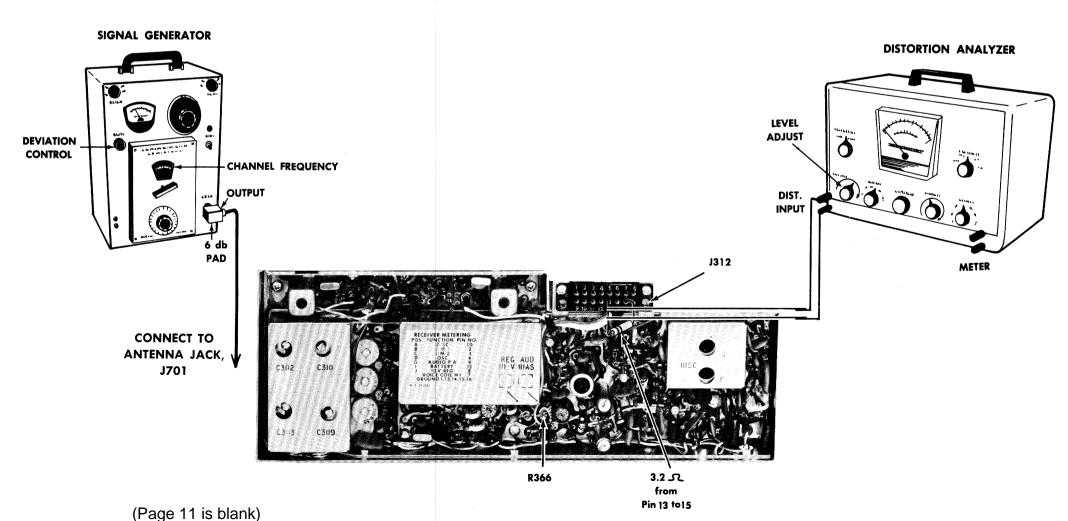
The Receiver Test Procedures are designed to help you to service the defective stage is pin-pointed, refer to the "Service Check" listed

TEST EQUIPMENT REQUIRED

for test hookup shown:

- 1. Distortion Analyzer similar to: Heath #IM-12
- 2. Signal Generator similar to: Measurements #M-560
- 3. 6 db attenuation pad

The test equipment is hooked to the receiver as shown for all Receiver Test Procedures.



STEP 1

AUDIO POWER OUTPUT AND DISTORTION

TEST PROCEDURE

Measure Audio Power Output as follows:

- 1. Connect a 1,000-microvolt test signal modulated by 1,000 Hertz \pm 3.0 kHz deviation to the antenna jack.
- 2. Disconnect the W-BL-O Speaker Hi lead from LS 701-2. Hook up a 3.2 ohm load resistor from Speaker Hi to ground as shown.
- 3. Connect Distortion Analyzer input across the 3.2-ohm resistor.
- 4. For standard receivers set VOLUME Control for one-watt output (1.79 VRMS).

VOLTMETER SCALE ON DISTORTION ANALYZER



ONE WATT

5. Make distortion measurements according to manufacturer's instructions. Reading should be less than 10% (5% is typical).

SERVICE CHECK

If the distortion is more than 10%, or maximum audio output is less than one watt, make the following checks:

- 1. Battery and regulator voltage—low voltage will cause distortion. (Refer to Receiver Schematic Diggram for voltages.)
- 2. Audio Bias Adjust (R366)—low current will cause distortion.
- 3. Audio Gain (Refer to Step 2A and 2B of Receiver Troubleshooting Procedure .
- 4. Discriminator Alignment (Refer to Receiver Alignment on reverse side of page).

STEP 2

USABLE SENSITIVITY (12 db SINAD)

TEST PROCEDURE

Measure sensitivity of the receiver modulated at the standard test modulation as follows:

- 1. Be sure Test Step 1 checks out properly.
- 2. Reduce the Signal Generator output from setting in TEST STEP 1.
- 3. Adjust Distortion Analyzer LEVEL control for a +2 db reading.
- 4. Set CONTROL for LEVEL to DISTORTION reading. Repeat Steps 1, 2, and 3 until difference in reading is 12 db (+2 db to -10 db).
- 5. The 12-db difference (Signal plus Noise And Distortion to noise plus distortion ratio) is the "usable" sensitivity level. Reading should be less than 0.3 microvolts with audio output at least $\frac{1}{2}$ watt (1.25 volts RMS across the 3.2-ohm receiver load).

VOLTMETER SCALE ON DISTORTION ANALYZER



SERVICE CHECK

If the sensitivity level is more than 0.3 microvolts, make the following checks

- 1. Alignment of RF stages (Refer to RF Alignment in Receiver Alignment on reverse side of page).
- 2. Gain measurements as shown on the Receiver Troubleshooting Procedure

STEP 3

MODULATION ACCEPTANCE BAND-WIDTH (IF BANDWIDTH)

TEST PROCEDURE

- 1. Be sure TEST STEPS 1 and 2 check out properly.
- 2. Set Signal Generator output for twice the microvolt reading obtained in TEST STEP 2 - 4.
- 3. Increase Signal Generator frequency deviation.
- 4. Adjust LEVEL Control for +2 db.

DB SCALE ON DISTORTION ANALYZER



5. Set CONTROL for LEVEL to DISTORTION reading. Repeat Steps 3, 4. and 5 until difference between readings becomes 12 db from +2 db to -10 db).

LEVEL DISTORTION **ON DISTORTION ANALYZER**

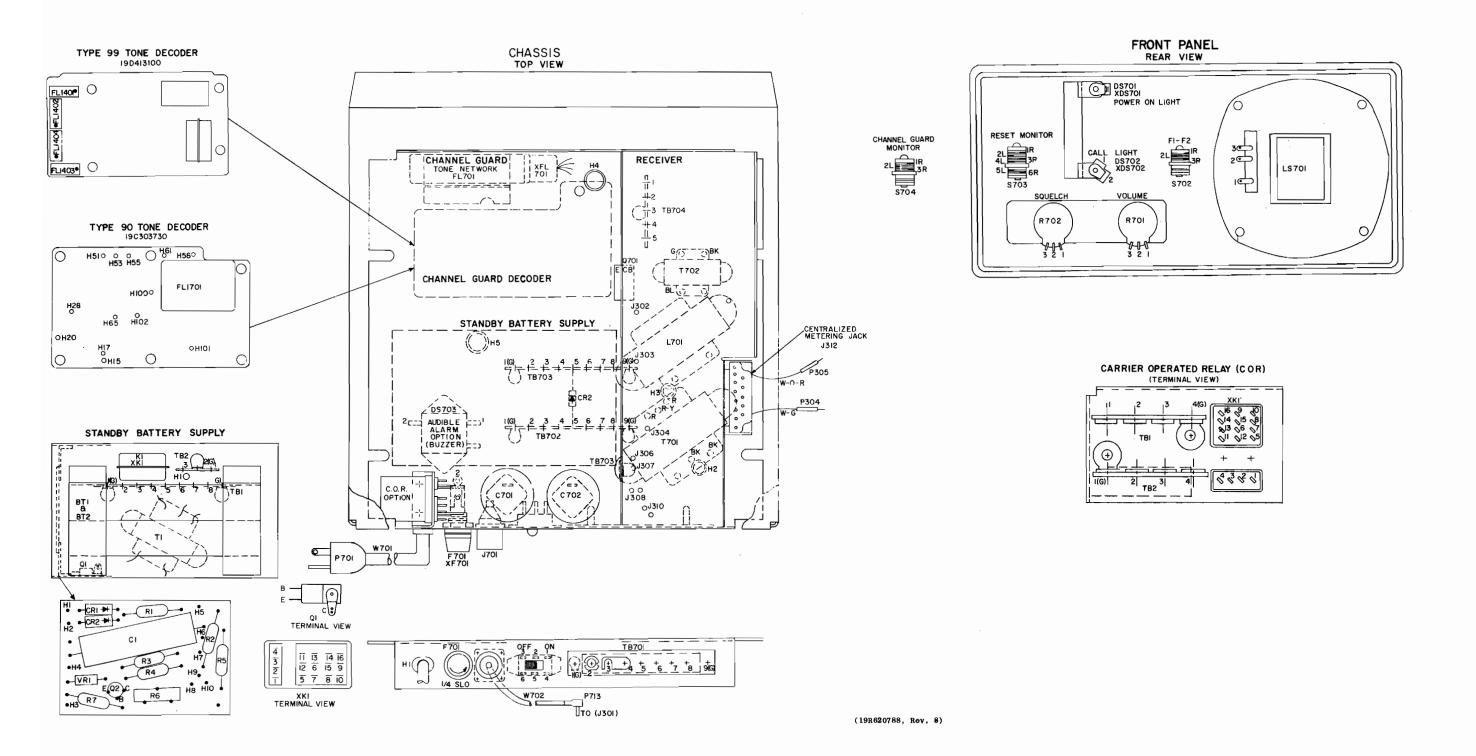


6. Deviation control reading for the 12-db difference is the Modulation Acceptance Bandwidth of the receiver. It should be more than \pm 6 kHz (typical value is \pm 9 kHz).

SERVICE CHECK

If the Modulation Acceptance Bandwidth test does not indicate the proper width, check the following:

- 1. Make gain measurements as shown on the Receiver Troubleshooting Procedure .
- 2. Voltage reading of 2nd Limiter (Q308) should read 0.4 volts RMS with a one-microvolt input signal on Test Set Meter or 0.9 volts with voltmeter. (Measure at J312-3).
- 3. DO NOT RE-ALIGN factory adjusted filters (L308 through L315), unless positive evidence of a defective filter is ascertained. (Refer to Filter Alignment on the Receiver Alignment Procedure.)

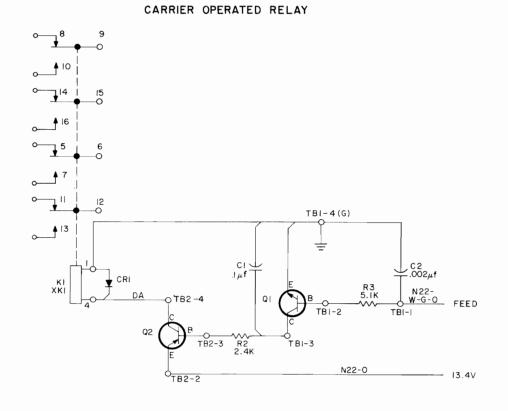


OUTLINE DIAGRAMS

MONITOR RECEIVER CHASSIS AND FRONT PANEL





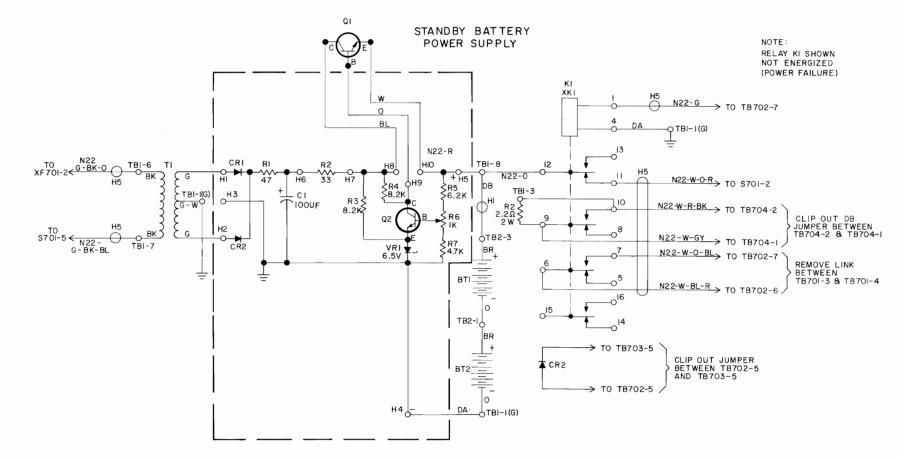


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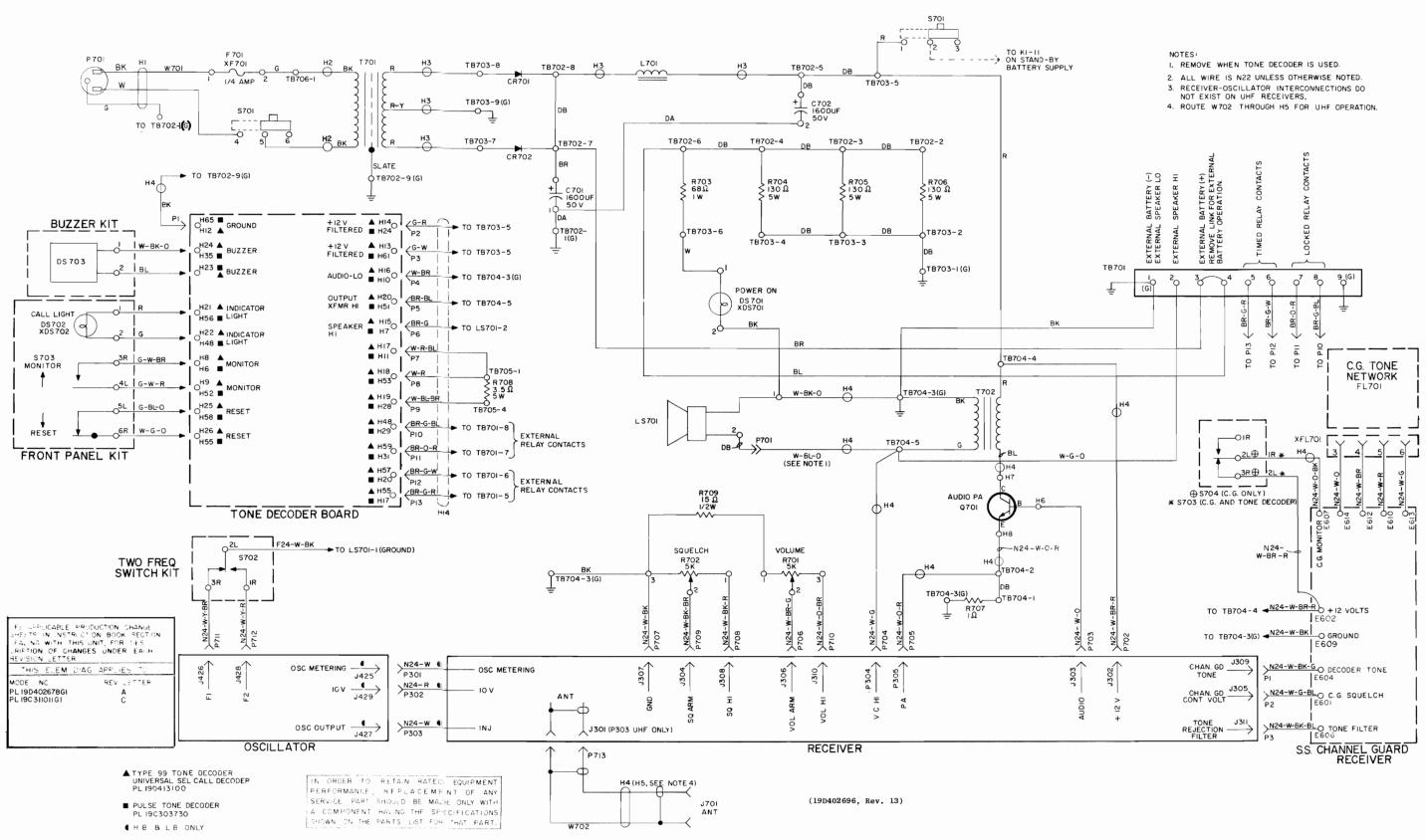
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(19C311361, Rev. 4)



(19C317160, Rev. 3)



LBI-3757

SCHEMATIC DIAGRAM MONITOR RECEIVER CHASSIS AND FRONT PANEL

LBI-3757

PARTS LIST

LBI-3754G

MONITOR RECEIVER MAIN CHASSIS 19C311011G1 FRONT PANEL ASSEMBLY 19D402678G1

SYMBOL	GE PART NO.	DESCRIPTION			403644191	In R Powe (P70
		MAIN CHASSIS ASSEMBLY 19C311011G1		¥702		
		CAPACITORS		1501	10001000	
C701 and C702	7476442P20	Electrolytic: 1600 μ f +250% -10%, 50 VDCW; sim to PR Mallory WP-068.		J701	4029493P1	Rece Equi
CR701 and	4037822P1	DIODES AND RECTIFIERS Silicon.		P713	5496078P6	 Righ
CR702					19B209044P11	RF:
F701	7487942P1	Slow blowing: 1/4 amp at 250 v; sim to Bussmann			100200011111	21-5
		MDL-1/4.				
1 701	10411505151	INDUCTORS		XF701	19B209005P1	Fuse
L701	19A115671P1	Reactor: 0.21 h min, 7.5 ohms DC res max, 20 VDC operating.				
		PLUGS				
P701		(Part of W701).		DS701	19C307037P19	
P702 and P703	4029840P2	Contact, electrical: sim to AMP 42827-2.		D 3701	190307037219	Lamp
P704 and P705	7147199P2	Connector: female contact; sim to Winchester Electronics 21804.		LS701	19B209101P1	Perm pape
P706 thru	4029840P2	Contact, electrical: sim to AMP 42827-2.				
P710 P713		(Part of W702).		P701	4036634P1	Cont
		TRANSFORM				
Q701*	19A116118P1	TRANSISTORS		R701	5496870P11	Vari sim
1		Earlier than REV B:		R702	5496870P15	Vari
	19A115527P1	Silicon, NPN.		R709	3R77P150K	sim Comp
		RESISTORS				
R703	3R78P680K	Composition: 68 ohms ±10%, 1 w.		XDS701	19B209342P1	Lamp
R704 thru R706	5493035 P 22	Wirewound: 130 ohms $\pm 5\%$, 5 w; sim to Tru-Ohm Type X-60.		Abbroi	156205542F1	Danip
R707	19B209022P115	Wirewound: 1 ohm $\pm 10\%$, 2 w; sim to IRC Type BWH.				
		SWITCHES		DS702	19C307037P19	Lamp
S701	7145098P1	Slide: DPDT, 0.75 amp at 125 VAC or 0.5 amp at 125 VDC; sim to Stackpole SS-150.		05702	190307037919	
		TRANSFORMERS		\$703	19B209139P5	Leve Posi
T701	19B209074P1	Power, step-down: single phase, Pri: 117 v, 50/60 Hertz, Sec 1: 850 ma at 13.8 VDC.				Posi lock
т702	19B209079P1	Audio freq: 0.3-3 KHz freq range, Pri: 55 ohms $\pm 10\%$ imp, 0.895 ohm $\pm 10\%$ DC res, Sec: 3.2 ohms imp, 0.168 ohm DC res.		XDS702	19B209342P1	
		TERMINAL BOARDS				
TB701	7117710P7	Phen: 7 terminals: sim to Cinch 1770				
TB702 and	7775500 P1 19	Phen: 9 terminals.				
TB703				DS703	19B200788P3	Buzz
TB704	7775500P11	Phen: 5 terminals.				with

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
: TB706	7775500P44	Phen: 2 terminals.			2 FREQUENCY SWITCH KIT
	-	CABLES			19A122310G1
W701*	19A116740P2	Power: approx 8 feet long, 2 poles, 3 wire		100001070	PLUGS
		grounding; sim to Belden 17239. In REV B and earlier:	P711 and P712	4029840P2	Contact, electrical: sim to AMP 42827-2.
:	4036441P1	Power: approx 6 feet long, with 2-contact plug (P701); sim to GE 2071-1.			SWITCHES
W702		CABLE 19A122691G1	S702	19B209139P4	Lever: 3 amps at 120 VAC, Position down: 1 form C contact, locking; sim to Switchcraft 28203L.
J701	4029493P1				HARDWARE KIT (CHANNEL GUARD) 19A122322G1
		Equiv. Military SO-239A.			
P713	5496078P6	Picht and a series of the seri	\$704	19A122310G2	Channel Guard Monitor. Includes:
F715	343007820	Right angle: coaxial; sim to FXR 27-6.		19B209139P4	Lever: 3 amps at 120 VAC, Position down: 1 form C contact, locking;
	19B209044P11	MISCELLANEOUS			sim to Switchcraft 28203L.
	198209044911	RF: approx 15 inches long; sim to Amphenol 21-598.			CABLE ASSEMBLY 19B205451G1 (TYPE 99 TONE DECODER) 19B205451G2 (TYPE 90 TONE DECODER)
XF701	19B209005P1				PLUGS
		sim to Littelfuse 342012.	Pl thru Pl3	4036634P1	Contact, electrical: sim to AMP 42428-2.
		19D402678G1	110		RESISTORS
			R708	5493035P10	Wirewound: 3.5 ohms $\pm 5\%$, 5 w; sim to Tru-Ohm Type X-60.
DS701	19C307037P19	Lamp, incandescent: 14 v; sim to GE 756.		1	Type x=00.
		LOUDSPEAKERS	TB705	7775500P8	
LS701	19B209101P1	Permanent magnet, 5-inch: 2-1/4 w operating, paper dust cap; sim to Cletron X10271.	15/05	111550026	Fien: 4 terminals.
		PLUGS			CABLE ASSEMBLY 19B205450G1 (CHANNEL GUARD) 19B205450G2 (CHANNEL GUARD AND TONE DECODER)
P701	4036634P1	Contact, electrical; sim to AMP 42428-2.			
		RESISTORS	P1	4029840P2	PLUGS
R701	5496870P11	Variable, carbon film: 5000 ohms ±20%, 0.25 w:	thru P3		on and the secondar. Sim to Amp +2021-2.
R702	5496870P15	sim to Mallory LC(5K). Variable, carbon film: 5000 ohms ±20%, 0.5 w;			SOCKETS
		sim to Mallory LC(5K).	XFL701	7768887P17	Tube, phen: 7 pins; sim to Elco 04-710-02.
R709	3R77P150K	Composition: 15 ohms $\pm 10\%$, $1/2$ w.			BATTERY KIT 19A122315G2
		SOCKETS			(Used with 19B205435G2).
XDS701	19B209342P1	Lampholder: sim to Leecraft 7-04-1.		v.	DIODES AND RECTIFIERS
		FRONT PANEL KIT 19A122311G1	CR2	4037822P1	Silicon.
					STAND-BY POWER SUPPLY 19B205435522
DS702	19C307037P19	Lamp, incandescent: 14 v; sim to GE 756.			(Used with 19A122315G2)
					BATTERIES
S703	19B209139P5	Lever: 3 amps at 120 VAC,	BT1 and	19B201887P2	Storage, nickel-cadmium: 6 v min; sim to GE 41B001AAQ1.
		Position up: 1 form B contact, momentary, Position down: 1 form A, 1 form B contacts, locking; sim to Switchcraft 28000 (Pt. 205-1007).	BT2		RELAYS
			K1	5491595P14	Armature: 1.5 w operating, 520 ohms $\pm 15\%$ coil
XDS702	19B209342P1	Lampholder: sim to Leecraft 7-04.			res, 4 form C contacts; sim to Allied Control T154-X-131.
		EXTERNAL ALARM KIT			TRANSISTORS
		EXTERNAL ALARM KIT 19A122312G1	Q1	19A116118P1	Silicon, NPN.
		INDICATING DEVICES			
DS703	19B200788P3	Buzzer: 12 VDC or 12-16 VAC nominal, 200 ma DC operating; sim to Line Electric BD-1. (Used with second relay, GE Dwg 19C300957P2).	R2	19B209022P123	Wirewound: 2.2 ohms $\pm 10\%,$ 2 w; sim to IRC Type BWH.

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL
	Tl	19B209017P1	Power: single phase,	TBil and
			Pri: 117 v, 50/60 Hz, Sec 1: 25/25 v.	TB;2
	тві	7775500P119	Phen: 9 terminals.	XK.1
	TB2	7775500₽7	Phen: 3 terminals.	
	ХКІ	5491595P5	Relay: 16 contacts; sim to Allied Control 30054-2.	C2:351
			STAND-BY POWER SUPPLY BOARD 19B216567G1	
	Cl	19A115680P12		
	CR1 and CR2	4037822P1	DIODES AND RECTIFIERS	
	Q2	19A115362P1		
			RESISTORS	
	Rl	3R77P470J	Composition: 47 ohms $\pm 5\%$, 1/2 w.	
	R2	3R77P330J	Composition: 33 ohms ±5%, 1/2 w.	
	R3 and R4	3R77P822J	Composition: 8200 ohms $\pm 5\%$, 1/2 w.	
I	R5	3R77P622J	Composition: 6200 ohms $\pm 5\%$, 1/2 w.	
l	R6	19B209358P103	Variable, carbon film: approx 25 to 1000 ohms $\pm 10\%$, 0.2 w; sim to CTS Type X-201.	
I	R7	3R77P472J	Composition: 4700 ohms $\pm 5\%$, $1/2$ w.	
	VR1	4036887P6		
			CARRIER OPERATED RELAY 19C303533G2	
I			CAPACITORS	
I	Cl	19A116080P7	Polyester: 0.1 μ f ±20%, 50 VDCW.	
	C2	7774750 ₽ 6	Ceramic disc: .002 µf +100% -0%, 500 VDCW.	
I	•	# 40 40 00 DI	DIODES AND RECTIFIERS	
	CR1	5494922P1	Silicon; sim to Type 1N456.	
	кі	5491595P14	Armature: 1.5 w max operating, 520 ohms ±15% coil res, 4 form C contacts rated at 0.5 amp at 12 VDC; sim to Allied Control T154-X-131.	
ł			TRANSISTORS	
	Q1	19A115123P1	Silicon, NPN; sim to Type 2N2712.	
	Q2	19A115706P1	Silicon, PNP.	
I		997750401		
I	R2	3R77P242J	Composition: 2400 ohms $\pm 5\%$, $1/2$ w.	
	R3	3R77P512J	Composition: 5100 ohms $\pm 5\%$, 1/2 w.	
l				
L				

OL	GE PART NO.	DESCRIPTION
1	7775500₽6	
L	5491595₽5	Relay: 16 contacts; sim to Allied Control 30054-2.
		IMPROVED INTERMODULATION 19A127250G1
351	5491271P103	
	19A122161G2	MISCELLANEOUS
	19A116768P8 19B205512G1	Bushing, strain relief: cable; sim to Heyco SR-5P-4. (Used with W701 in 19C311011G1). Casting. (Used in 19D402678G1).
	19C303769P1 N529P16D	Grille. (Used in 19D402678G1). Button plug: approx 15/32 inch dia. (Used in 19D402678GI).
	19A122240P1 4037559P9 19C307038P6 19B204349P3	Support. (Used with XD\$701 in 19D402678G1). Bumper, rubber. (Used in 19D402678G1). Nut, push-on. (Holds jewel in 19D402678G1). Jewel: amber. (Used in 19D402678G1).
	19A122210P1 4034668P1	Lens, green. (Used with XDS702 in 19D402678Gl). (Not Used).
	19A115679P1 NP248990	<pre>Knob, push-on: black. (Used with R702, 703 in 19D402678G1). Nameplate. (Used in 19D402678G1).</pre>
	4036634P1 5491595P9	Contact, electrical. (Used in 19A122311G1). Retainer, spring. (Used with K1 in 19B205435G2).
		1

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for description of parts affected by these revisions.

- REV. A (19C311011-G1 only) To change antenna connector from phono to UHF Type. Changed W702.
- REV. A (19D402678-Gl only) To make minimum volume level consistent with requirements of tone decoders and to change the ground circuit for indicator lamp DS701. Changed R709 and XDS701.
- REV. B (19C311011-Gl only) To incorporate a different audio transistor. Changed Q701.
- REV. C To incorporate a 3-wire power cable. Changed W701.

PARTS LIST

LBI-3758C

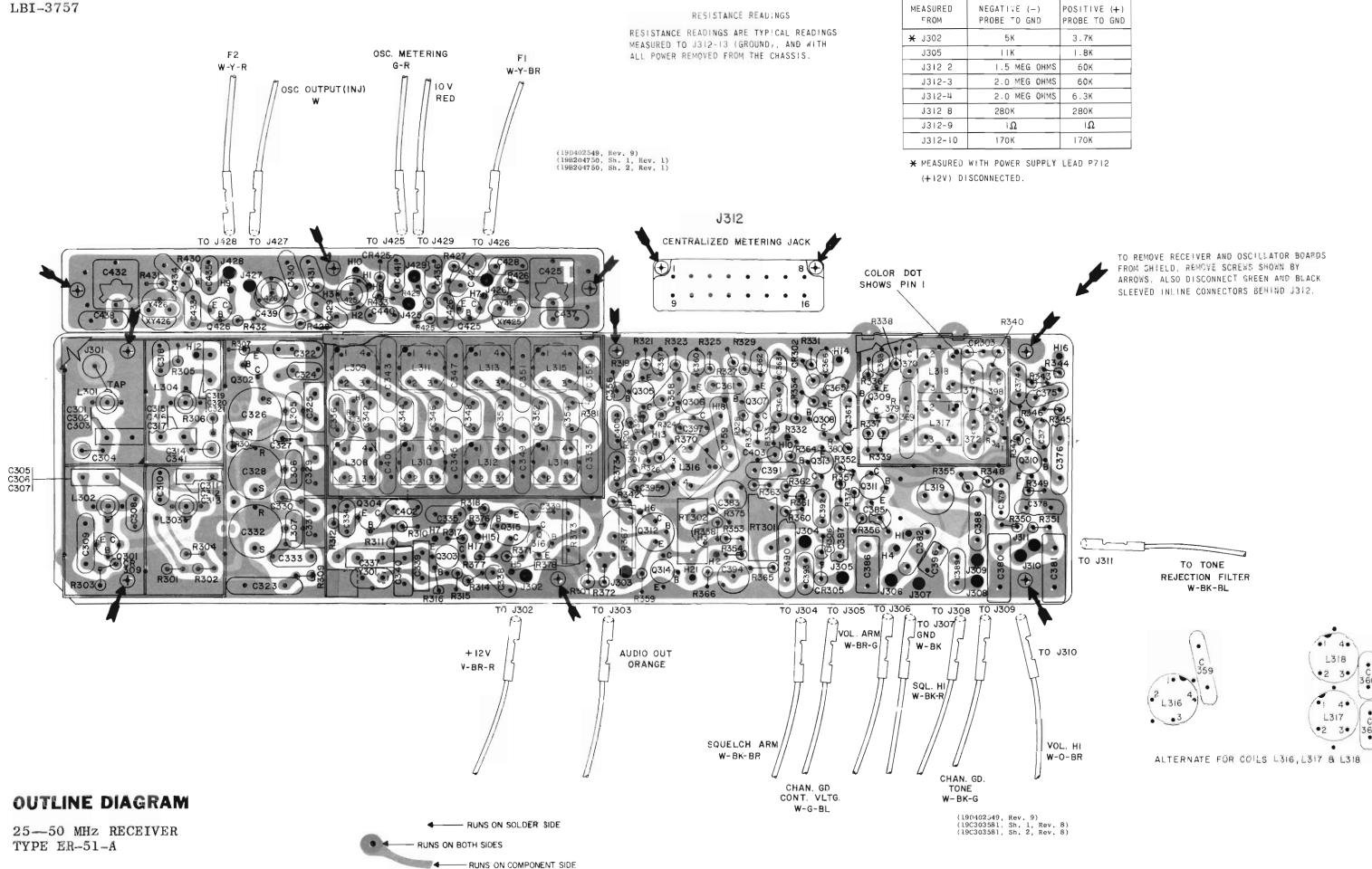
25 - 50 MHz RECEIVER TYPE ER-51-A

RECEIVER BOARD 19D402429G1 THRU G3 OSCILLATOR BOARD 4EG19A10 AND 4EGA19A11

BECELVER BOARDS 23-33 Miz Board 19040242003 33-42 Miz Board 19040242003 42-50 Miz Board 19040242003 C33 C301 5490008P24 Silver mica: 75 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C302 5490008P19 Silver mica: 27 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C303 5490008P13 Silver mica: 27 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C304 7130348P4 Molded: 2.2 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C305 5490008P13 Silver mica: 27 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C306 5490008P13 Silver mica: 27 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C307 5490008P13 Silver mica: 27 pf 155, 500 VDCW; sim to Electro Motive Type DM-15. C33 C308 7491827P2 Cermatic disc: .01 µf +80% -30%, 50 VDCW; sim to Motive Type DM-15. C33 C310 7491827P2 Cermatic disc: .10 µf +80% -30%, 50 VDCW; sim to Electro Motive Type DM-15. C34 C311 5490008P13 Silver mica: 27 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C312 5490008P13 Silver mica: 36 pf 15%, 500 VDCW; sim to Electro Motive Type DM-1	SYMBOL	GE PART NO.	DESCRIPTION	C330
C3015490008P24Silver mics: 75 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3025490008P19Silver mics: 27 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3035490008P13Silver mics: 27 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3047130348P4Moided: 2.2 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3055490008P24Silver mics: 75 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3065490008P19Silver mics: 27 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3075490008P13Silver mics: 27 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C33C3087491827P2Ceramic disc: .01 pf +80% -30%, 50 VDCW; sim to Sprague 196180.C33C3107491827P2Ceramic disc: .01 pf +80% -30%, 50 VDCW; sim to Electro Motive Type DM-15.C33C3115490008P24Silver mics: 75 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3135490008P24Silver mics: 27 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3147130348P3Nolded phen: 1 pf 1.06 pf ,500 VDCW; sim to Electro Motive Type DM-15.C34C3155490008P13Silver mics: 23 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3165490008P17Silver mics: 23 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3175490008P11Silver mics: 35 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3187491827P2C			25-33 MHz Board 19D402429Gl 33-42 MHz Board 19D402429G2	C330
C305S490008P24Silver mica: 75 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C3065490008P19Silver mica: 27 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C33C3075490008P13Silver mica: 27 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C33C3087491827P2Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to 	C302	5490008P19	Silver mica: 75 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15. Silver mica: 47 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15. Silver mica: 27 pf \pm 5%, 500 VDCW; sim to Electro	C332 C333 C334
C307S490008P13Silver mica: S102 27 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.and to Electro C33C3087491827P2Ceramic disc: Sprague 19C18001 μ f +80% -30%, 50 VDCW; sim to Electro MCTVP Type DM-15.C33C3095494481P115Ceramic disc: Sprague 19C18001 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C33C3107491827P2Ceramic disc: Sprague Type 19C18001 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C33C3115490008P24Silver mica: Motive Type DM-1502 VDCW; sim to Electro Motive Type DM-15.C34C3125490008P13Silver mica: Silver mica: Motive Type DM-1502 VDCW; sim to Electro Motive Type DM-15.C34C3147130348P3Molded, phen: Motive Type DM-1502 VDCW; sim to Electro Motive Type DM-15.C34C3165490008P17Silver mica: Silver mica: 	C305	5490008P24	approx O PPM; sim to Jeffers Type JM-5/32. Silver mica: 75 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.	
C309 5494481P115 Ceramic disc: 3000 pf $\pm 20\%$, 500 VDCW; sim to RWC Type JF Discap. C310 7491827P2 Ceramic disc: .01 µf +80\% -30\%, 50 VDCW; sim to RWC Type JF Discap. C31 C311 5490008P24 Silver mica: 75 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C33 C312 5490008P19 Silver mica: 47 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C313 5490008P13 Silver mica: 27 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C314 7130348P3 Nolded, phen: 1 pf ±.05 pf, 500 VDCW; sim to Electro Motive Type DM-15. C34 C315 5490008P11 Silver mica: 29 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C316 5490008P17 Silver mica: 22 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C318 7491827P2 Ceramic disc: .01 µf +80\% -30\%, 50 VDCW; sim to Electro Motive Type DM-15. C34 C320 5490008P17 Silver mica: 39 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C321 5490008P17 Silver mica: 30 pf ±5\%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C322 5490008P17 Silver mica: 30 pf ±5\%, 500 VDCW; sim to Electro Motive Typ	C307	5490008P13	Motive Type DM-15. Silver mica: 27 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	C335 and C336 C337
C312S490008P19Stiver Type DM-15.Stor Total, Start of Field of C34C3135490008P13Silver mica: 47 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3147130348P3Molded, phen: 1 pf $\pm .05$ pf ± 00 VDCW; sim to Electro Motive Type DM-15.C34C3155490008P11Silver mica: 56 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3165490008P17Silver mica: 39 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3175490008P11Silver mica: 22 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3187491827P2Ceramic disc: .01 µf $\pm 80\%$ -300%, 50 VDCW; sim to Silver mica: 39 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3205490008P17Silver mica: 27 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3215490008P13Silver mica: 27 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C35C3225494481P115Ceramic disc: .00 µf $\pm 20\%$, 500 VDCW; sim to RMC Type JF Discap.C35C32319A116080P7Polyester: 0.1 µf $\pm 20\%$, 500 VDCW; sim to Sprague Type 19C180.C35C3247491827P2Ceramic disc: .01 µf $\pm 30\%$ -30%, 50 VDCW; sim to Earlier than EEV H in G1; Earlier than EEV G in G2, G3:C35C325*5491870P140JMica: 140 pf $\pm 5\%$, 300 VDCW; sim to Electro Motive Type DM-15.C35C3265490048P29Silver mica: 120 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C35C3265490046P1Variable, ceramic: approx 8-50			Ceramic disc: 3000 pf ±20%, 500 VDCW; sim to RMC Type JF Discap. Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to	C338
C3147130348P3Nolded, phen: l pf \pm .05 pf, 500 VDCW, temp coef 0 PPW; sim to Jeffers Type JM-5/32.C34C3155490008P21Silver mica: 56 pf \pm %, 500 VDCW; sim to Electro Motive Type DM-15.C34C3165490008P17Silver mica: 29 pf \pm %, 500 VDCW; sim to Electro Motive Type DM-15.C34C3175490008P11Silver mica: 22 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3187491827P2Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C34C3195490008P21Silver mica: 26 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3205490008P21Silver mica: 29 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3215490008P17Silver mica: 27 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.C35C3225490008P13Silver mica: 27 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.C35C32319A116080P7Polyester: 0.1 µf \pm 20%, 500 VDCW; sim to Sprague Type 19C180.C35C3247491827P2Ceramic disc: .01 µf \pm 80% $-$ 30%, 50 VDCW; sim to Sprague Type 19C180.C35C3247491827P2Ceramic disc: .01 µf \pm 80% $-$ 30%, 50 VDCW; sim to Sprague Type 19C180.C35C325*5491870P140JMica: 140 pf \pm 5%, 300 VDCW; sim to Electro Motive Type DM-15.C35C3265490008P29Silver mica: 120 pf \pm 5%, 500 VDCW; sin to Electro Motive Type DM-15.C35C3265490446P1Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef $-$ 750 PPM; sin to Erie Style 557-36. <td>C312</td> <td>5490008P19</td> <td>Motive Type DM-15. Silver mica: 47 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.</td> <td>C339 and C340 C341</br></br></td>	C312	5490008 P 19	Motive Type DM-15. Silver mica: 47 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	C339 and
Notive Type DM-15.100 HetterC34C3165490008P17Silver mica: 39 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3175490008P11Silver mica: 22 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3187491827P2Ceramic disc: .01 µf $\pm 80\%$ -30% , 50 VDCW; sim to Sprague Type 19C180.C34C3195490008P21Silver mica: 56 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3205490008P17Silver mica: 39 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C34C3215490008P13Silver mica: 27 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C35C322549408P13Silver mica: 27 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C35C32319A116080P7Polyester: 0.1 µf $\pm 20\%$, 50 VDCW, sim to Sprague Type 19C180.C35C3247491827P2Ceramic disc: .01 µf $\pm 80\% - 30\%$, 50 VDCW; sim to Sprague Type 19C180.C35C325*5491870P140JMica: 140 pf $\pm 5\%$, 300 VDCW; sim to Electro Motive Type DM-15.C35C326549008P29Silver mica: 120 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.C35C3265490446P1Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef -750 PDM; sim to Erie Style 557-36.C35C3277130348P1Molded: 0.47 pf $\pm.047$ pf, 500 VDCW, temp coef	C314	7130348 P 3	Molided, phen: 1 pf ±.05 pf, 500 VDCW, temp coef 0 PPM; sim to Jeffers Type JM-5/32.	C342 C343
C3187491827P2Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C34C3195490008P21Silver mica: 56 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3205490008P17Silver mica: 39 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.C34C3215490008P13Silver mica: 27 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.C35C322549408P13Silver mica: 27 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.C35C32319A116080P7Polyester: 0.1 μ f ±20%, 50 VDCW; sim to Sprague Type 19C180.C35C3247491827P2Ceramic disc: .01 μ f ±80% -30%, 50 VDCW; sim to 	C316	5490008P17	Motive Type DM-15. Silver mica: 39 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro	C344
C320 5490008P17 Silver mica: 39 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. C34 C321 5490008P13 Silver mica: 27 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. C35 C322 5494481P115 Ceramic disc: 3000 pf ±20%, 500 VDCW; sim to MMC Type DM-15. C35 C323 19A116080P7 Polyester: 0.1 µf ±20%, 50 VDCW. C35 C324 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C35 C325* 5491870P140J Mica: 140 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15. C35 C326 5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. C35 C326 5490446P1 Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie Style 557-36. C35 C327 7130348P1 Molded: 0.47 pf ±.047 pf, 500 VDCW, temp coef			worlve Type DM-15. Ceramic disc: .01 μf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. Silver mica: 56 pf ±5%, 500 VDCW; sim to Electro	C346
RMC Type JF Discap. C35 C323 19A116080P7 Polyester: 0.1 µf ±20%, 50 VDCW. C35 C324 7491827P2 Ceramic disc: .01 µf ±80% -30%, 50 VDCW; sim to Sprague Type 19C180. C35 C325* 5491870P140J Mica: 140 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15. C35 C326 5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. C35 C326 5490446P1 Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef C35 C327 7130348P1 Molded: 0.47 pf ±.047 pf, 500 VDCW, temp coef C35			Motive Type DM-15. Silver mica: 27 pf ±5%, 500 VDCW; sim to Electro	C349
C325* 5491870P140J Mica: 140 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15. C35 Earlier than REV H in Gl; Earlier than REV G in G2, G3: C35 5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. C35 C326 5490446P1 Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Eric Style 557-36. C327 C327 7130348P1 Molded: 0,47 pf ±.047 pf, 500 VDCW, temp coef C35	C323	19A116080P7	RMC Type JF Discap. Polyester: 0.1 μ f \pm 20%, 50 VDCW. Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to	C351 C352
5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. C35 C326 5490446P1 Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie Style 557-36. C35 C327 7130348P1 Molded: 0.47 pf ±.047 pf, 500 VDCW, temp coef C35	C325*	5491870P140J	Sprague Type 19C180. Mica: 140 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15. Earlier than REV H in Gl;	C353 C354
C327 7130348P1 Molded: 0.47 pf ±.047 pf, 500 VDCW, temp coef	C326		Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. Variable, ceramic: approx 8-50 pf, 350 VDCW.	C355
	C327	713034891	Molded: 0.47 pf ±.047 pf, 500 VDCW, temp coef	

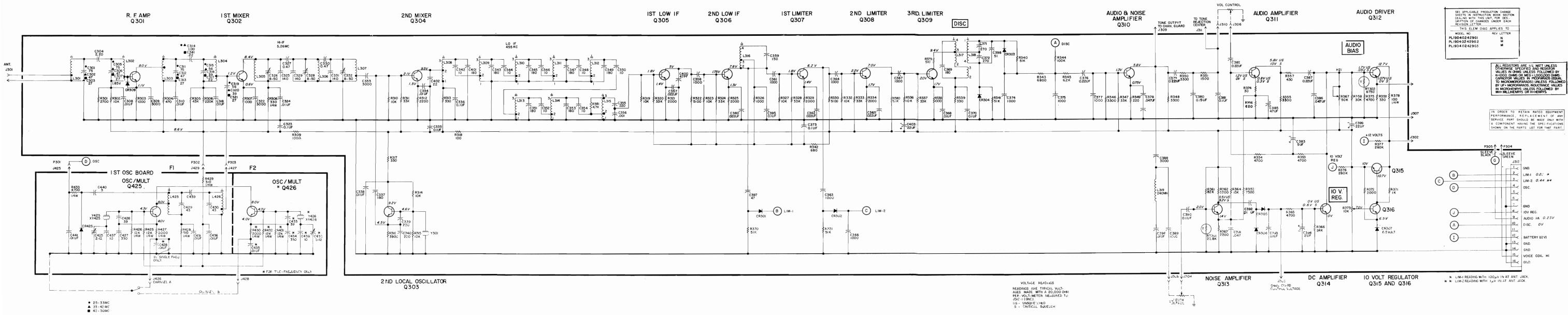
SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	LBI-3757
C328	5490446P1	Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie Style 557-36.	C356*	5494481 P 111	Ceramic disc: 1000 pf $\pm 20\%$, 1000 VDCW; sim to	25
C329*	5491870P140J	Mica: 140 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15.			RMC Type JF Discap. In 19D402429Gl of REV L and earlier:	
		Earlier than REV H in Gl:		7491930 P 3	In 19D402429G2, G3 of REV K and earlier: Polyester: .0047 µf ±20%, 100 VDCW; sim to	
	5490008 P 29	Earlier than REV G in G2, G3: Silver mica: 120 pf ±5%, 500 VDCW; sim to	C357*	19A116080P3	GE Type 61F. Polyester: 0.022 µf ±20%, 50 VDCW.	
C330	7130348P1	Electro Motive Type DM-15. Molded: 0.47 pf ±.047 pf, 500 VDCW, temp coef		20112200000	Earlier than REV H in Gl:	
		approx 0 PPM; sim to Jeffers Type JM-5/32.		5492638P101	Earlier than REV G in G2, G3: Ceramic disc: 0.1 µf +100% -0%, 3 VDCW; sim to	
C331*	5491870P140J	Mica: 140 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15.	C358	5494481P112	Sprague Type 54C23. Ceramic disc: 1000 pf $\pm 10\%$, 500 VDCW; sim to RMC	
		Earlier than REV H in Gl: Earlier than REV G in G2, G3:	C359	5496219P367	Type JF. Ceramic disc: 150 pf ±5%, 500 VDCW, temp coef	
	5490008P29	Silver mica: 120 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.	C360*		-150 PPM.	
C332	5490446P1	Variable, ceramic: approx 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie Style 557-36.	0.360*	19A116080P3	Polyester: 0.022 µf ±20%, 50 VDCW. Earlier than REV H in Gl:	
C333	5494481P115	Ceramic disc: 3000 pf $\pm 20\%$, 500 VDCW; sim to RMC Type JF Discap.		5492638P101	Earlier than REV G in G2, G3: Ceramic disc: 0.1 µf +100% -0%, 3 VDCW; sim to	
C334+	19A116080P1	Polyester: .01 μ f ±20%, 50 VDCW.	C361	5494481P112	Sprague Type 54C23.	
		In Gl REV D and earlier: In G2 and G3 REV C and earlier:			Ceramic disc: 1000 pf $\pm 10\%$, 500 VDCW; sim to RMC Type JF Discap.	
	7491827 P 2	Ceramic disc: .01 μf +80% -30%, 50 VDCW; sim to Sprague Type 19C180.	C362*	19A116080P3	Polyester: 0.022 µf ±20%, 50 VDCW. Earlier than REV H in Gl:	
C335 and	19A116080P107	Polyester: 0.1 μ f ±20%, 50 VDCW.		5492638P101	Earlier than \overrightarrow{REV} G in G2, G3: Ceramic disc: 0.1 μ f +100% -0%, 3 VDCW; sim to	
C336 C337	5490008P33	Silver mica: 180 pf ±5%, 500 VDCW; sim to	C363	7491393P1	Sprague Type 54C23.	
		Electro Motive Type DM-15.			Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.	
C338*	19A116080P1	Polyester: .01 µf ±20%, 50 VDCW. In Gl REV D and earlier:	C364	5494481P112	Ceramic disc: 1000 pf ±10%, 500 VDCW; sim to RMC Type JF Discap.	
	7491827P2	In G2 and G3 REV C and earlier: Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to	C365*	19A116080P3	Polyester: 0.022 µf ±20%, 50 VDCW. Earlier than REV H in Gl:	[
C339	5490008P35	Sprague Type 19C180. Silver mica: 220 pf ±5%, 500 VDCW; sim to		5492638P101	Earlier than REV G in G2, G3:	
and C340	3450008F35	Electro Motive Type DM-15.			Ceramic disc: 0.1 µf +100% -0%, 3 VDCW; sim to Sprague Type 54C23.	
C341	7130348 P9	Molded: 0.22 pf ±.022 pf, 500 VDCW, temp coef approx 0 PPM; sim to Jeffers Type JM-5/32.	C366	7491393P1	Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.	
C342	5496219 P 41	Ceramic disc: 10 pf ±5%, 500 VDCW, temp coef 0 PPM.	C367	5494481P112	Ceramic disc: 1000 pf $\pm 10\%$, 500 VDCW; sim to RMC Type JF Discap.	
C343	19A116656P180J1	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	C368*	19A116080P1	Polyester: .01 μf ±20%, 50 VDCW.	
C344	5496219P41	-150 PPM. Ceramic disc: 10 pf ±0.25 pf, 500 VDCW, temp coef		1	In Gl REV C or earlier: In G2 and G3 REV B or earlier:	
C345	19A116656P180J1	0 PPM. Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef		7491827P2	Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180.	
C346	5496219 P 41	-150 PPM. Ceramic disc: 10 pf ±0.25 pf, 500 VDCW, temp	C369	19A116656P180J1	Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM.	
	19A116656P180J1	coef 0 PPM.	C370	19A116080P107	Polyester: 0.1 μ f $\pm 10\%$, 50 VDCW.	
C347		Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM.	C371 and C372	5490008P37	Silver mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	
C348	5496219 P 41	Ceramic disc: 10 pf ± 0.25 pf, 500 VDCW, temp coef 0 PPM.	C373	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	
C349	19A116656P180J1	Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM.	C374 and C375	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$, 500 VDCW; sim to RMC Type JF.	
C350	5496219 P 41	Ceramic disc: 10 pf ± 0.25 pf, 500 VDCW, temp coef 0 PPM.	C375 C376	19A116080P109	Polyester: 0.22 µf ±10%, 50 VDCW.	
C351	19A116656P180J1	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef -150 PPM.	C377*	5494481P11	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	
C352	5496219 P 41	Ceramic disc: 10 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.			Earlier than REV G in G1:	
C353	19A116656P180J1	Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef		5494481 P 107	Earlier than REV F in G2, G3: Ceramic disc: 470 pf $\pm 20\%$, 500 VDCW; sim to RMC	
C354	5496219P41	-150 PPM. Ceramic disc: 10 pf ±0.25 pf, 500 VDCW, temp	C378	19A116080P5	Type JF Discap. Polycster: .047 μ f ±20%, 50 VDCW.	
C355*	7489162P35	coef 0 ppm. Silver mica: 220 pf ±5%, 500 VDCW; sim to	C379*	19A116080P109	Polyester: 0.22 µf ±10%, 50 VDCW.	
		Electro Motive Type DM-15.			Earlier than REV A:	
		In 19D402429Gl of REV L and earlier: In 19D402429G2, G3 of REV K and earlier:		5492638P107	Ceramic disc: 0.1 µf +80% -20%, 12 VDCW; sim to Sprague 20C202.	
	19A116656P180J1	Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM.				

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES



POSITIVE (+) PROBE TO GND
3.7K
I.8K
60K
60К
6.3K
280K
Ω
170K





SCHEMATIC DIAGRAM

25-50 MHz RECEIVER TYPE ER-51-A

19R620718, Rev. 21

LBI-3757

LBI-3	757					[Т]									PRODUCTION CHANGES
SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBO	L GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	Changes in the equipment to improve performance or to simplify circuits are
																		identified by a "Revision Leter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions.
C380*	19A116080P8	Polyester: 0.15 uf ±20%, 50 VDCW,	CR309*	4038642P1	Germanium. Added in Gl by REV D. Added in G2	Q312	19A115300P4	Silicon, NPN; sim to Type 2N3053.	R339	3R77P331K	Composition: 330 ohms $\pm 10\%$, 1/2 w.	R375	3R77P472J	Composition: 4700 ohms $\pm 5\%$, 1/2 w.			TRANSISTORS	Refer to the Parts List for descriptions of parts affected by these revisions
0000		Earlier than REV A:	1		and G3 by REV C.	Q313*	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R340 and	3R77P513J	Composition: 51,000 ohms $\pm 5\%$, $1/2$ w.	R376 and	5495948P444	Deposited carbon: 0.28 megohm $\pm 1\%$, 1/2 w; sim to Texas Inst CD1/2MR.	Q425 and	19A115245P1	Silicon, NPN.	REV. A - (25-50 MHz Receiver Boards 19D402429-G1, 2 and 3)
	19B209243P7	Polyester: 0.1 µf ±20%, 50 VDCW.			JACKS AND RECEPTACLES			In 19D402429G1 of REV L and earlier: In 19D402429G2, G3 of REV K and earlier:	R341			R377			Q426	1		To improve audio response. C379, C380 C386, R355 and R356 were changed. C384 was deleted.
C381	19A116080P7	Polyester: 0.1 μ f ±20%, 50 VDCW.	J301	5496078P3	Receptacle, push-on: sim to FXR 27-3.		19A115123P1	Silicon, NPN; sim to Type 2N2712.	R342	3R152P681K	Composition: $680 \text{ ohms } \pm 10\%$, $1/4 \text{ w}$.	R378*	3R152P101K	Composition: 100 ohms $\pm 10\%$, 1/4 w. Added in G1 by REV F. Added in G2 and G3 by			RESISTORS	REV. B - (25-33 MHz Receiver Board 19D402429-G1 Only)
C382	19A116080P109	Polyester: 0.22 μ f ±10%, 50 VDCW.	J302 thru	4033513P4	Pin, contact: sim to Bead Chain L93-3.	Q314*	19A116755P1	Silicon, NPN; sim to Type 2N3947.	R343 R344	3R77P682K 3R77P104K	Composition: 6800 ohms $\pm 10\%$, 1/2 w. Composition: 0.1 megohm $\pm 10\%$, 1/2 w.	R379*	3R152P511J	REV E. Composition: 510 ohms $\pm 5\%$, 1/4 w. Added in Gl	R425 and	3R152P123J	Composition: 12,000 ohms $\pm 5\%$, 1/4 w.	To improve tuning of front end and oscillator circuits. C319 was
C383	5495670P3	Electrolytic: 5 μ f +75% -10%, 6 VDCW; sim to Sprague 30D125A1.	J311 J312	19B205689G2	Connector: 18 contacts,			In 19D402429G1 of REV M and earlier:	R345*	3R77P622J	Composition: $6200 \text{ ohms } \pm 5\%$, $1/2 \text{ w}$.	KJ15*	5815275115	by REV L. Added in G2, G3 by REV K.	R426			changed.
C384*	5494481P114	Ceramic disc: 2000 pf ±10%, 500 VDCW; sim to	0.012	19820308902	connector: 18 contacts.		19A115123P1	In 19D40242962, G3 of REV L and earlier: Silicon, NPN; sim to Type 2N2712.			In 19D402429Gl of REV L and earlier:	R380*	3R152P512J	Composition: 5100 ohms $\pm 5\%$, $1/4$ w. Added in Gl by REV K. Added in G2, G3 by REV J.	R427	3R152P202J 3R152P511J	Composition: 2000 ohms ±5%, 1/4 w.	REV. C - (25-33 MHz Receiver Board 190402429-G1 Only) REV. B - (33-42 MHz Receiver Board 190402429-G2 Only) REV. B - (42-50 MHz Receiver Board 190402429-G3 Only)
C385	5496267P2	RMC Type JF. Deleted by REV A. Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague			INDUCTORS	Q315	19A115300P2	Silicon, NPN; sim to Type 2N3053.		3R77P153K	In 19D402429G2, G3 of REV K and earlier:	R381*	3R152P472K	Composition: 4700 ohms $\pm 10\%$, 1/4 w.	and R429	3815225113	Composition: 510 ohms ±5%, 1/4 w.	To reduce squelch clipping at high signal levels. C404 was added fro
0000	040020172	Type 150D.	L301	19C303583G3	Coil. Includes tuning slug 19B200497P2.	Q316*	19A116755P1	Silicon, NPN; sim to Type 2N3947.	R346	3R77P153K 3R77P332K	Composition: 15,000 ohms ±10%, 1/2 w. Composition: 3300 ohms ±10%, 1/2 w.			Added to 19D402429Gl by REV M. Added to 19D402429G2, G3 by REV L.	R430)	3R152P202J	Composition: 2000 ohms $\pm 5\%$, 1/4 w.	the top of CR308 to the top of R364.
C386*	19A116080P5	Polyester: .047 μf $\pm 20\%,$ 50 VDCW.	L302 L303	19C303583G4 19C303583G2	Coil. Includes tuning slug 19B200497P2. Coil. Includes tuning slug 19B200497P2.			In 19D402429G1 of REV M and earlier:	R347	3R77P333K	Composition: 33,000 ohms ±10%, 1/2 w.				R431	3R152P123J	Composition: 12,000 ohms ±5%, 1/4 w.	REV. D - (25-33 MHz Receiver Board 190402429-G1 Only) REV. C - (33-42 MHz Receiver Board 190402429-G2 Only) REV. C - (42-50 MHz Receiver Board 191402429-G3 Only)
		Earlier than REV A:	L303	19C303583G1	Coil. Includes tuning slug 19B200497P2.		19A115123P1	In 19D402429G2, G3 of REV L and earlier: Silicon, NPN; sim to Type 2N2712.	R348	3R77P332K	Composition: 3300 ohms ±10%, 1/2 w.	RT301	5490828P29	Rod: 22,800 ohms ±5% res at 25°C. 1 w max input	and R432:	[To improve squelch operation temperature extremes and to protect trans
	5491189P105	Polyester: .068 µf ±20%, 50 VDCW; sim to Good-All Type 601PE.	L305	19B204932G2	Coil. Includes tuning slug 19B200497P2.		19A115125P1	Silicon, NPR; sim to Type 2N2/12.	R349	3R77P221K	Composition: 220 ohms $\pm 10\%$, $1/2$ w.			at 40°C; sim to Globar 723B-1.	R433:	3R152P472J	Composition: 4700 ohms $\pm 5\%$, 1/4 w.	istor Q301 from very strong signals. CR309 was added across the emitter and base of Q301. R360 was deleted. C368, C392 and R361 were
C387	19A116080P109	Polyester: 0.22 μ f ±10%, 50 VDCW.	and L306					RESISTORS	R350	3r77p332j	Composition: 3300 ohms $\pm 5\%$, 1/2 w.	RT302	5490828P28	Rod: 8750 ohms $\pm 5\%$ res at 25°C, 1 w max input at 40°C; sim to Globar 723F-2.			SOCKETS	changed.
C388	5494481P116	Ceramic disc: 3000 pf $\pm 10\%$, 500 VDCW; sim to RMC Type JF Discap.	L307	19B204932G1	Coil Assembly.	R301	3R77P272J	Composition: 2700 ohms $\pm 5\%$, $1/2$ w.	R351	3R77P152J	Composition: 1500 ohms $\pm 5\%$, 1/2 w.			CRYSTALS	XY4265	5490277P1	Transistor: 4 contacts, low-loss mica-filled	REV. E - (25-33 MHz Receiver Board 19D402429-G1 Only) REV. D - (33-42 MHz Receiver Board 19D402429-G2 Only)
C389	5494481P112	Ceramic disc: 1000 pf ±10%, 500 VDCW; sim to RMC	L308* thru	19A115711P1	Transformer, freq: 455 KHz; sim to Automatic Mfg EX12670.	R302	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.	R352	3R77P752J	Composition: 7500 ohms $\pm 5\%$, 1/2 w.	¥301	19B206356P1	Quartz: antiresonant, frequency 4805,00 KHz.	and XY4216		phenolic; sim to Elco 3303.	REV. D - <u>(42-50 MHz Receiver Board 19D402429-G3 Only)</u> To improve temperature stability at temperature extremes. Changed
0200	74010075-	Type JF.	L315*		Mrg EX12670. Earlier than REV J in Gl:	R303 R304	3R77P102K 3R77P471K	Composition: 1000 ohms $\pm 10\%$, 1/2 w. Composition: 470 ohms $\pm 10\%$, 1/2 w.	R353 and	3R77P472K	Composition: 4700 ohms ±10%, 1/2 w.							To improve temperature stability at temperature extremes. Changed C334 and C338.
C390	7491827₽5	Ceramic disc: 0.1 μ f +80% -30%, 50 VDCW; sim to Sprague Type 36Cl72.			Earlier than REV H in G2, G3:	R305	3R77P433J	Composition: 43,000 ohms ±5%, 1/2 w.	R354	0		11		OSCILLATOR BOARDS 1-Freq Board Model 4EG19A10 (19C303591G1)			NOTE THE ALL AND A CRYSTALS	REV. F - (25-33 MHz Receiver Board 19D402429-G1 Only) REV. E - (33-42 MHz Receiver Board 19D402429-G2 Only)
C391*	19A116080P105	Polyester: 0.047 µf ±10%, 50 VDCW.		19C303062G6	Coil, Includes tuning slug 19B200497P2.	R306	3R77P224K	Composition: 0.22 megohm ±10%, 1/2 w.	R355*	3R77P332K	Composition: 3300 ohms $\pm 10\%$, $1/2$ w. In Models earlier than REV A:			2-Freq Board Model 4EG19All (19C303591G2)			<u>NOTE</u> : When reordering give GE Part Number and specify exact frequency needed.	REV. E - $\frac{(42-50 \text{ MHz} \text{ Receiver Board 19D402429-G3 Only)}}{(42-50 \text{ MHz} \text{ Receiver Board 19D402429-G3 Only)}}$
		In 19D402429Gl of REV L and earlier: In 19D402429G2, G3 of REV K and earlier:	L316*	19A115711P2	Transformer, freq: 455 KHz; sim to Automatic Mfg EX12671.	R307	3R77P102J	Composition: 1000 ohms ±5%, 1/2 w.		3R77P222K	Composition: 2200 ohms ±10%, 1/2 w.			CAPACITORS			25-33 MHz Crystal Frequency = (OF +5.26 MHz) ÷ 2.	To minimize the affects of line voltage transients on receiver operation. Added R378.
	19A116080P109	Polyester: 0.22 μ f ±10%, 50 VDCW.			Earlier than REV J in G1: Earlier than REV H in G2, G3:	R308	3R152P331K	Composition: 330 ohms $\pm 10\%$, 1/4 w.	R356*	3R77P621J	Composition: 620 ohms $\pm 5\%$, $1/2$ w.	C425	5491271P106	Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189.			33-42 MHz Crystal Frequency = (OF -5.26 MHz) ÷ 2.	REV. G - (25-33 MHz Receiver Board 19D402429-G1 Only) REV. F - (33-42 MHz Receiver Board 19D402429-G2 Only)
C392*	19A116080P1	Polyester: .01 µf ±20%, 50 VDCW.		19C303062G6	Coil. Includes tuning slug 19B200497P2.	R309*	3R77P101K	Composition: 100 ohms $\pm 10\%$, 1/2 w.			In Models earlier than REV A:	C426	5496218P653	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef	¥425	100000000000	42-50 MHz Crystal Frequency = (OF -5.26 MHz) \div 3.	REV. F - $(33-42 \text{ MHz Receiver Board 19D402429-G2 Only})$ REV. F - $(42-50 \text{ MHz Receiver Board 19D402429-G3 Only})$
		In Gl REV C or earlier:	L317*	19A115711P6	Transformer, freq: 455 KHz; sim to TOKO PEFCN-			In 19D402429Gl of REV L and earlier: In 19D402429G2, G3 of REV K and earlier:		3R77P431J	Composition: 430 ohms $\pm 5\%$, $1/2$ w.			-470 PPM.	and Y426	19B206357P1	Quartz: antiresonant, freq range 12-19 MHz.	To eliminate 455 kHz from the squelch circuit and lower maximum squelc opening level. Changed C377.
	7491827P2	In G2 and G3 REV B or earlier: Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to		1	14733-CX12.		3R77P471K	Composition: 470 ohms $\pm 10\%$, $1/2$ w.	R357	3R77P431J	Composition: 430 ohms $\pm 5\%$, 1/2 w.	C427	5490008P39	Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	1120			
		Sprague 19C180.			Earlier than REV J in G1: Earlier than REV H in G2, G3:	R310	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.	R358*	3R77P303J	Composition: 30,000 ohms $\pm 5\%$, $1/2$ w.	C428	7491827P2	Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.			MISCELLANEOUS	REV. H - (25-33 MHz Receiver Board 19D402429-G1 Only) REV. G - (33-42 MHz Receiver Board 19D402429-G2 Only) REV. G - (42-50 MHz Receiver Board 19D402429-G3 Only)
C393	19A116080P109	Polyester: 0.22 μ f ±10%, 50 VDCW.		19C303062G4	Coil. Includes tuning slug 19B200497P2.	R311	3R77P333K	Composition: 33,000 ohms $\pm 10\%$, $1/2$ w.			In 19D402429Gl of REV M and earlier: In 19D402429G2, G3 of REV L and earlier:	C429	5496218P54	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef		4036555P1	Insulator, washer: nylon. (Used with Q312 and Q315).	To improve temperature compensation of high IF circuits. Changed C325 C329: and C331.
C394	5495670P13	Electrolytic: 2 µf +75% -10%, 25 VDCW; sim to Sprague Type 30D176A1.	L318*	19A115711P7	Transformer, freq: 455 KHz; sim to TOKO PEFCN- 14734-BNL2.	R312	3R77P222K	Composition: 2200 ohms $\pm 10\%$, $1/2$ w.		3R77P622J	Composition: 6200 ohms $\pm 3\%$, $1/2$ w.	and C430		O PPM.				To utilize improved bypass capacitors in low IF. Changed C357, C360,
C395	19A116080P107	Polyester: 0.1 $\mu f \pm 10\%$, 50 VDCW.			Earlier than REV J in G1:	R313	3R77P331K	Composition: 330 ohms ±10%, 1/2 w.	R359	3R77P331K	Composition: 330 ohms $\pm 10\%$, $1/2$ w.	C431	7491827P2	Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to				C362, and C365.
C396	19A116080P201	Polyester: .01 μf ±5%, 50 VDCW.		1000000000	Earlier than REV H in G2, G3:	R314 and	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.	R360*	3R152P104J	Composition: 0.1 megohm ±5%, 1/4 w. Deleted from Gl by REV D. Deleted from G2 and G3 by REV	C432	5491271P106	Sprague Type 19C180. Variable, subminiature: approx 2.1-12.7 pf,				REV. J - (25-33 MHz Receiver Board 19D402429-G1 Only) REV. H - (33-42 MHz Receiver Board 19D402429-G2 Only)
C397	5496203P117	Ceramic disc: 47 pf ±10%, 500 VDCW, temp coef -3300 PPM.	L319	19C303062G5 5491736P2	Coil. Includes tuning slug 19B200497P2. Inductor: 240 mh ±10% ind at 0.5 v. 270 ohms	R315 R316	3R77P392K				C.	0452	54512711100	750 v peak; sim to EF Johnson 189.				REV. H - (42-50 MHz Receiver Board 19D402429-G3 Only)
C398	5496219P656	Ceramic disc: 51 pf ±5%, 500 VDCW, temp coef	1319	545175022	max DC res; sim to Aladdin 33-161.	R310 R317	3R77P392K 3R77P331K	Composition: 3900 ohms ±10%, 1/2 w. Composition: 330 ohms ±10%, 1/2 w.	R361*	3R77P823J	Composition: 82,000 ohms $\pm 5\%$, 1/2 w.	C433	5496218P653	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef -470 PPM.		1		To facilitate manufacturing and procurement of parts. Changed L308–L318, R367 and R373.
C399	5496267P10	-470 PPM.				R318	3R77P101K	Composition: 100 ohms $\pm 10\%$, 1/2 w.			In Gl REV C or earlier: In G2 and G3 REV B or earlier:	C434	5490008P39	Silver mica: 330 pf ±5%, 500 VDCW; sim to				REV. K - (25-33 MHz Receiver Board 19D402429-G1 Only) REV. J - (33-42 MHz Receiver Board 19D402429-G2 Only)
0055	0400201210	Tantalum: 22 μf $\pm 20\%,$ 15 VDCW; sim to Sprague Type 150D.	P301	4029840P2	Contact, electrical: sim to Amp 42827-2.	R319	3R77P103K	Composition: 10,000 chms ±10%, 1/2 w.		3R152P753J	Composition: 75,000 ohms $\pm 5\%$, 1/4 w.	C425	7491827P2	Electro Motive Type DM-15.				REV. J - (42-50 MHz Receiver Board 19D402429-G3 Only)
C400	5496219P817	Ceramic disc: 47 pf $\pm 10\%$, 500 VDCW, temp coef -1500 PPM.	p303			R320	3R77P333K	Composition: 33,000 ohms $\pm 10\%$, $1/2$ w.	R362	3R77P332J	Composition: 3300 ohms $\pm 5\%$, $1/2$ w.	C435 and C436	745162722	Ceramic disc: .01 μf +80% -30%, 50 VDCW; sim to Sprague Type 19C180.				To prevent squelch lock-up at high signal levels. Deleted C404. Changed CR308.
C401	5496219 P 369	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	P304 and	7147199P1	Connector: 1 male contact; sim to Winchester Electronics 21803.	R321	3R77P202J	Composition: 2000 ohms $\pm 5\%$, 1/2 w.	R363	3R77P222J	Composition: 2200 ohms $\pm 5\%$, 1/2 w.	C437	5490008P6	Silver mica: 10 pf ±5%, 500 VDCW; sim to Electro				REV. L - (25-33 MHz Receiver Board 19D402429-61 Only) REV. K - (33-42 MHz Receiver Board 19D402429-62 Only)
0400	5 400000001	-150 PPM.	P305			R322	3R77P512J	Composition: 5100 ohms $\pm 5\%$, 1/2 w.	R364	3R77P153J	Composition: 15,000 ohms $\pm 5\%$, 1/2 w.	and C438		Motive Type DM-15.		}		REV. K - $(33-42$ MHz Receiver Board 19D402429-G2 Only) REV. K - $(42-50$ MHz Receiver Board 19D402429-G3 Only)
C402	5490008P11	Silver mica: 22 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.			TRANSISTORS	R323	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.	R365 R366	3R77P472K	Composition: 4700 ohms $\pm 10\%$, $1/2$ w.	C439	7130348P3	Molded: 1 pf ±.05 pf, 500 VDCW, temp coef approx				To improve discriminator idling and tuning. Added P379.
C403	5496267P10	Tantalum: 22 μ f ±20%, 15 VDCW; sim to Sprague Type 150D.	Q301 and	19A115342P1	Silicon, NPN.	R324	3R77P333K	Composition: 33,000 ohms $\pm 10\%$, 1/2 w.	R367*	3R77P243J 19B209358P108	Composition: 24,000 ohms $\pm 5\%$, 1/2 w.	C440	5496218P34	0 PPM; sim to Jeffers Type JM-5/32.				REV. M - (25-33 MHz Receiver Board 19D402424-Gl only)
C404*	7489162P139	Silver mica: 330 pf $\pm 10\%$, 500 VDCW; sim to	Q302	10411589001		R325	3R77P202J	Composition: 2000 ohms $\pm 5\%$, $1/2$ w.		1552055562108	Variable, carbon film: approx 100 to 50,000 ohms $\pm 10\%$, 0.25 w; sim to CTS Type X-201.	0440	5496218P34	Ceramic disc: 3 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.				REV. M - (25-33 MHz Receiver Board 19D402424-G1 only) REV. L - (33-42 MHz Receiver Board 19D402429-G2 only) REV. L - (42-50 MHz Receiver Board 19D402429-G3 only)
		Electro Motive Type DM-15. Added in G1 by REV C, Deleted in G1 by REV K. Added in G2 and G3 by	Q303 Q304	19A115889P1 19A115342P1	Silicon, NPN; sim to Type 2N2712. Silicon, NPN.	R326 R327	3R77P102K 3R77P103K	Composition: 1000 ohms ±10%, 1/2 w. Composition: 10,000 ohms ±10%, 1/2 w.			Earlier than REV J in G1: Earlier than REV H in G2, G3:	C441	7491827₽2	Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.				To improve discriminator "idling", to increase maximum squelch opening
		REV B, Deleted in G2, G3 by REV J.	Q305*	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R328	3R77P333K	Composition: 33,000 ohms ±10%, 1/2 w.		19B204808G1	Resistor Assembly. Includes resistor, variable,							level, and to increase squelch clopping at 3000 Hz. Changed R309, R345, C355, C356, C391, Q305, Q306, and Q313. Added R381.
		DIODES AND RECTIFIERS	and Q306*			R329	3R77P202J	Composition: 2000 ohms ±10%, 1/2 w.	R370	3R77P513J	carbon film: 50,000 ohms ±20%, 0.1 w.	00405	7777146P3	DIODES AND RECTIFIERS				REV. N - (25-33 MHz Receiver Board 19D402429-G1 only)
CR301 and	7777146₽3	Germanium; sim to Type 1N90.			In 19D402429Gl of REV L and earlier: In 19D402429G2, G3 of REV K and earlier:	R330	3R77P512J	Composition: 5100 ohms ±5%, 1/2 w.	R370 R371	3R77P102J	Composition: 51,000 ohms ±5%, 1/2 w. Composition: 1000 ohms ±5%, 1/2 w.	CR425	////146P3	Germanium; sim to Type 1N90.				AEV. M - (33-42 MHz Receiver Board 19D402429-G2 only) REV. M - (42-50 MHz Receiver Board 19D402429-G3 only)
CR302				19A115889P1	Silicon, NPN; sim to Type 2N2712.	R331	3R77P513J	Composition: 51,000 ohms $\pm 5\%$, 1/2 w.	R372	3R77P202J	Composition: 2000 ohms $\pm 5\%$, 1/2 w.			JACKS AND RECEPTACLES				To incorporate new transistors. Changed Q303, Q307, Q308, Q309, Q310,
CR303 and CR304	19A115250P1	Silicon.	Q307 thru	19A115889P1	Silicon, NPN; sim to Type 2N2712.	R332	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, $1/2$ w.	R373*	19B209358P106	Variable, carbon film: approx 75 to 10,000 ohms	J425 thru	4033513P4	Contact, electrical: sim to Bead Chain L93-3.				Q311, Q314, and Q316. Changed R358.
CR304 CR305	7777146P3	Germanium; sim to Type 1N90.	Q309			R333	3R77P333K	Composition: 33,000 ohms $\pm 10\%$, $1/2$ w.			$\pm 20\%$, 0.25 w; sim to CTS Type X-201.	J429						
and CR306		Germanitum, Sim to Type 1N90,	Q310* and	19A116755P1	Silicon, NPN; sim to Type 2N3947.	R334	3R77P202J	Composition: 2000 ohms $\pm 5\%$, $1/2$ w.			Earlier than REV J in G1: Earlier than REV H in G2, G3:	1.405	1000475000					
CR307	4036887P6	Silicon, Zener.	Q311*		In 19D402429Gl of REV M and earlier:	R336 R337	3R77P103K 3R77P333K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.		19B204808G2	Resistor Assembly. Includes resistor, variable, carbon film: $10,000$ ohms $\pm 20\%$, 0.1 w.	L425 L426	19B204752G2 19B204752G1	Coil. Includes tuning slug 716051991. Coil. Includes tuning slug 716051991.				
CR308*	403688723	Silicon, Zener. Deleted in Gl by REV K. Deleted		19A115123P1	In 19D402429G2, G3 of REV L and earlier: Silicon, NPN; sim to Type 2N2712.	R337	3R77P333K 3R77P102J	Composition: 33,000 ohms $\pm 10\%$, 1/2 w.	R374	3R77P300J	Composition: 30 ohms ±5%, 1/2 w.	5425	15520475201	corr. Incrudes cuntuk sing (10051351.				
i l		in G2, G3 by REV J.		15811512391	Sillon, MPR, Sim to type 202112.		011111020	Composition: 1000 ohms $\pm 5\%$, 1/2 w.			τ							
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PARTS LIST

LBI-3759D

132–174 MHz RECEIVER – TYPE ER-52–A 132–174 MHz FIRST OSCILLATOR – MODELS 4EG20A10–13

IBDIG257GI C33 C301 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C302 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C304 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C305 5490008P131 Silver mica: 150 pf ±10%, 500 VDCW; sim to Electro Motive Type DPM-15. C33 C306* 19A116655P20 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C307 7491333P1 Ceramic disc: 001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sprague Type 19C180. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sim to EF Johnson 189. C33 C310 19A116656P5J8 Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sim to EF Johnson 189. C33 C312 7491393P1 Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sprague Type JF Discap. C33 C312 7491393P2 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C313*	
IBDIG257GI C33 C301 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C302 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C304 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C305 5490008P131 Silver mica: 150 pf ±10%, 500 VDCW; sim to Electro Motive Type DPM-15. C33 C306* 19A116655P20 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C307 7491333P1 Ceramic disc: 001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sprague Type 19C180. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sim to EF Johnson 189. C33 C310 19A116656P5J8 Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sim to EF Johnson 189. C33 C312 7491393P1 Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sprague Type JF Discap. C33 C312 7491393P2 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C313*	
C301 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 YDCW, temp C302 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C304 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 YDCW, temp C33 C305 5490008P131 Silver mica: 150 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15. C33 C306* 19A116655P20 Ceramic disc: .000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C307 7491393P1 Ceramic disc: .01 µf +80% -30%, 500 VDCW; sim to Sprague Type 1219C4. C33 C308 19A116656P5J8 Ceramic disc: .01 µf +80% -30%, 500 VDCW; sim to Sprague Type 19E080. C33 C309 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C310 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp C33 C311 19A116656P5J8 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C312 7491393P1 Ceramic disc: .00 µf +100% -0%, 500 VDCW; sim to Sprague Type JF Discap. C33 C312 7491393P2 Ceramic disc: .00 µf +100% -0%, 500 VDCW; sim to Sprague Type JF Discap. C33 <td>C329</td>	C329
C302 and C3035491271P106Variable, subminiature: Sim to EF Johnson 189.C33C30419A116656P5J8Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM.C33C3055490008P131Silver mica: 150 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.C33C306*19A116655P20Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to Electro Motive Type DM-15.C33C306*19A116655P20Ceramic disc: .000 pf ±10%, 1000 VDCW; sim to Electro Motive Type DM-15.C33C3077491393P1Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.C33C30819A116656P5J8Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sprague Type 1219C4.C33C309 and C3105491271P106Variable, subminiature: 2.1-12.7 pf, 750 v peak; sin to EF Johnson 189.C33C31119A116656P5J8Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM.C33C3127491393P2Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.C33C3127491393P2Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sprague Type JF Discap.C33C313*5494481P114Ceramic disc: 1000 pf 10%, 1000 VDCW; sim to RMC Type JF Discap.C33C3147491393P1Ceramic disc: 001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1218C4.C33C3147491827P2Ceramic disc: 001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1218C4.C33C3155490446P1Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36.C34 </td <td>C330*</td>	C330*
and sim to EF Johnson 189. C33 C304 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C305 5490008P131 Silver mica: 150 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15. C33 C306* 19A116655P20 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C307 7491393P1 Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sprague Type 19C180. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW; sim to Sprague Type 19C180. C33 C309 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C312 7491393P2 Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to RMC Type JF Discap. C33 C312 7491393P1 Ceramic disc: 1000 pf 1000 VDCW; sim to RMC Type JF Discap. C33 C313* 5494481P112 Ceramic disc: 1000 pf 1000 VDCW; sim to RMC Type JF Discap. C33 . Earlier than REV H: Caramic disc: .01 µf +100% -0%, 500 VDCW; sim to	
C305 5490008P131 Silver mics: 150 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15. C33 C306* 19A116655P20 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C307 7491393P1 Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C308 19A116656P5J8 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 1219C4. C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C309 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C312 7491393P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C313* 5494481P114 Ceramic disc: .000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C314 7491827P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 121806. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34 <td>C331</td>	C331
Electro Motive Type DM-15.C306*19A116655P20Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap. Earlier than REV E:C337491393P1Ceramic disc: .001 μ f +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.C33C3077491827P102Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C33C30819A116656P5J8Ceramic disc: 5 pf ± 0.5 pf, 500 VDCW; temp coef -80 PPM.C33C3105491271P106Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189.C33C31119A116656P5J8Ceramic disc: 5 pf ± 0.5 pf, 500 VDCW, temp coef -80 PPM.C33C3127491393P2Ceramic disc: .01 μ f +100% -0%, 500 VDCW; sim to Sprague Type 1218C4.C33C313*5494481P114Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap. Earlier than REV E: 7491393P1Caramic disc: .001 μ f $\pm 100\%$ -0%, 500 VDCW; sim to RMC Type JF Discap.C33C3147491827P2Ceramic disc: .01 μ f $\pm 100\%$ -0%, 500 VDCW; sim to Sprague Type 1219C4.C33C3155490446P1Variable, ceramic: 8-50 pf, 350 VDCW; temp coef -750 PPM; sim to Erie 557-36.C34	C332*
C306* 19A116655P20 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C333 7491393P1 Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C333 C307 7491827P102 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C334 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C338 C309 and C310 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sin to EF Johnson 189. C33 C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C311 19A116656P5J8 Ceramic disc: 101 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C312 7491393P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type JF Discap. C33 C313* 5494481P114 Ceramic disc: 1000 pf, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV H: Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 1218C4. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	
7491393P1Ceramic disc: .001 μ f +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.C33.C3077491827P102Ceramic disc: .01 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C33.C30819A116656P5J8Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM.C33.C309 and C3105491271P106Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189.C33.C31119A116656P5J8Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM.C33.C3127491393P2Ceramic disc: .01 μ f +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.C33.C313*5494481P114Ceramic disc: 2000 pf, 1000 VDCW; sim to RMC Type JF Discap. Earlier than REV H: Caramic disc: .000 μ f +100% -0%, 500 VDCW; sim to RMC Type JF Discap.C33.C3147491827P2Ceramic disc: .001 μ f +100% -0%, 500 VDCW; sim to Sprague Type 1219C4.C33.C3147491827P2Ceramic disc: .001 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C33.C3147491827P2Ceramic disc: .001 μ f +80% -30%, 50 VDCW; sim to Sprague Type 19C180.C34.	
C307 7491827P102 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to C33 C308 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp C33 C309 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C310 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp C33 C310 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp C33 C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp C33 C312 7491393P2 Ceramic disc: 2000 pf, 1000 VDCW; sim to Sprague Type 1219C4. C33 C313* 5494481P114 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 . Earlier than REV H: C33 . Earlier than REV E: C33 . Earlier than REV E: Caramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C314 7491827P2 Ceramic disc: .001 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C34 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	C333
Sprague Type 19C180. C308 19A116656P5J8 Ceramic disc: 5 pf ± 0.5 pf, 500 VDCW, temp coef -80 PPM. C309 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C311 19A116656P5J8 Ceramic disc: 5 pf ± 0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C312 7491393P2 Ceramic disc: 0.01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C313* 5494481P114 Ceramic disc: 1000 pf, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV H: Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap. C33 C314 7491827P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .000 µf $\pm 10\%$, 1000 VDCW; sim to SPrague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .001 µf $\pm 10\%$, 500 VDCW; sim to SPrague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .001 µf $\pm 80\%$ -30%, 50 VDCW; sim to SPrague Type 1219C4. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW; temp coef -750 PPM; sim to Erie 557-36. C33	C334*
C309 and C310 5491271P106 Variable, subminiature: 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C33 C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C312 7491393P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C313* 5494481P114 Ceramic disc: 2000 pf, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV H: Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C314 7491393P1 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C34 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	
and C310 sim to EF Johnson 189. C33 C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -80 PPM. C33 C312 7491393P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C313* 5494481P114 Ceramic disc: 2000 pf, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV H: Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 5494481P112 Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 C314 7491393P1 Ceramic disc: .01 µf ±80% -30%, 50 VDCW; sim to Sprague Type 19C180. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	
C311 19A116656P5J8 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp C312 7491393P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim C313* 5494481P114 Ceramic disc: 2000 pf, 1000 VDCW; sim to RMC Type JF Discap. Earlier than REV H: C491393P1 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. . Earlier than REV E: . C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C315 5490446P1	C335
C312 7491393P2 Ceramic disc: .01 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C313* 5494481P114 Ceramic disc: 2000 pf, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV H: 5494481P112 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV H: Ceramic disc: .000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV E: Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C34 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	C336*
RMC Type JF Discap. C33 Earlier than REV H: C33 5494481P112 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV E: Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C33 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	
5494481P112 Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap. C33 Earlier than REV E: 7491393P1 Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C314 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	C337
RMC Type JF Discap. Earlier than REV E: 7491393P1 Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36.	C338*
7491393P1 Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague Type 1219C4. C333 C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C333 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C344	
C314 7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C33 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	
C314 7491827P2 Ceramic disc: .01 μf +80% -30%, 50 VDCW; sim to Sprague Type 19C180. C34 C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36. C34	C339
C315 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef -750 PPM; sim to Erie 557-36.	
	C340*
C316 5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	
C317 7130348P1 Molded, phen: 0.47 pf ±.047 pf, 500 VDCW, temp coef 0 PPM; sim to Jeffers Type JM-5/32. C34	C341
C318 5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to	C342
C319 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef	C343
C320 7130348P1 Molded, phen: 0.47 pf ±.047 pf, 500 VDCW, temp	
C321 5490008P29 Silver mica: 120 pf ±5%, 500 VDCW; sim to	C344
C322 5490446P1 Variable, ceramic: 8-50 pf, 350 VDCW, temp coef	C345
C323 7491930P4 Polyester: .0068 µf ±20%, 100 VDCW; sim to GE Type 61F.	C346*
C324* 19A116080P1 Polyester: .01 µf ±20%, 50 VDCW.	
Earlier than REV F: C34	C347
7491827P2 Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague Type 19C180.	

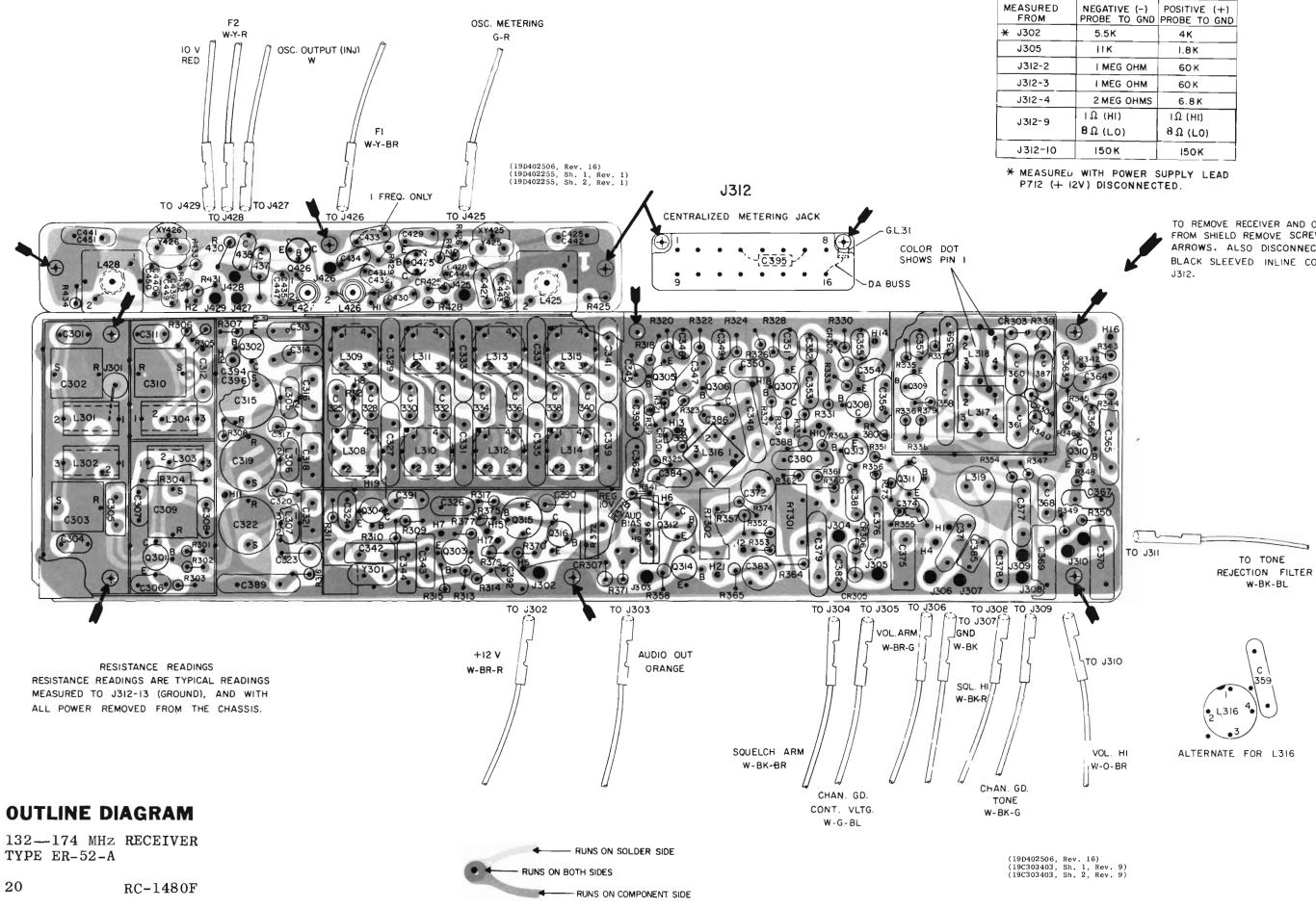
SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.
C325	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	C348	5496219 P 367
and C326 C327	54069100260		C349*	19A116080P3
	5496219P369	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef -150 PPM.		
C328*	5496219 P 43	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef 0 PPM.		5492638P101
	5496219P42	In REV N and earlier: Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef	C350	5494481P112
C329	54962199369	0 PPM. Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	C351*	19A116080P3
C330*	5496219P43	-150 PPM.		5492638P101
0000	5450215245	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef 0 PPM.	C352	7491393P1
	5496219 P 42	In REV N and earlier: Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef	C353	5494481P112
C331	5496219P369	O PPM. Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	C354*	19A116080P3
C332*	5496219P43	-150 PPM.	0001	10011000000
0002	5450215245	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef 0 PPM.		5492638P101
	5496219 P 42	In REV N and earlier: Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef	C355	7491393P1
C333	5496219P369	O PPM. Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef	C356	5494481 P 112
C334*	5496219P43	-150 PPM. Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef	C357*	19A116080P1
0001	0400210740	0 PPM.		
	5496219P42	In REV N and earlier: Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef		7491827P2
C335	549621 9 P369	0 PPM. Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	C358	5496219P369
C336*	5496219P43	-150 PPM. Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef	C359 C360	19A116080P107 5490008P37
		O PPM.	and C361	5450008257
	5496219P42	In REV N and earlier: Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef	C362	19A116080P107
C337	5496219P369	O PPM. Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	C363 and C364	5494481P111
C338*	5496219 P 43	-150 PPM. Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef	C365	19A116080P109
		O PPM. In REV N and earlier:	C366*	5494481P11
	5496219P42	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef 0 PPM.		5494481P107
C339	5496219P369	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef	0007	
C340*	5496219P43	-150 PPM. Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef	C367 C368*	19A116080P5 19A116080P109
		0 PPM. In REV N and earlier:		
	5496219P42	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef 0 PPM.		5492638P107
C341	5496219P369	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef -150 PPM.	C369*	19A116080P8
C342	5496219 ₽ 50	Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef 0 PPM.		19B209243P7
C343	5490008P19	Silver mica: 47 pf ±5%, 500 VDCW; sim to	C370	19A116080P7
C344	5490008P23	Electro Motive Type DM-15. Silver mica: 68 pf ±5%, 500 VDCW; sim to	C371 C372	19A116080P109 5495670P3
C345	7491930P3	Electro Motive Type DM-15. Polyester: .0047 µf ±20%, 100 VDCW; sim	C373*	5494481P114
C346*	19A116080P3	to GE Type 61F. Polyester: 0.022 $\mu f \pm 20\%$, 50 VDCW.	C374	5496267P2
0.010	13411008043	Barlier than REV K:		
	5492638P101	Ceramic disc: 0.1 µf +100% -0%, 3 VDCW; sim to Sprague 54C23.	C375*	19A116080P5
C347	5494481P112	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF.		19B209243P6

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

DESCRIPTION

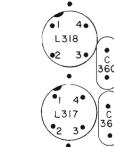
Ceramic disc: 150 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM. Polyester: 0.022 μf $\pm 20\%,$ 50 VDCW. Earlier than REV K: Ceramic disc: 0.1 μf +100% -0%, 3 VDCW; sim to Sprague 54C23. Ceramic disc: 1000 pf \pm 10%, 1000 VDCW; sim to RMC Type JF. Polyester: 0.022 µf ±20%, 50 VDCW. Earlier than REV K: Ceramic disc: 0.1 μf +100% -0%, 3 VDCW; sim to Sprague 54C23. Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague 1219C4. Ceramic disc: 1000 pf $\pm 10\%,$ 1000 VDCW; sim to RMC Type JF. Polyester: 0.022 μ f ±20%, 50 VDCW. Earlier than REV K: Ceramic disc: 0.1 μf +100% -0%, 3 VDCW; sim to Sprague 54C23. Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague 1219C4. Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF. Polyester: .01 μ f ±20%, 50 VDCW. Earlier than REV E: Ceramic disc: .01 µf +80% -30%, 50 VDCW; sim to Sprague 19C180. Ceramic disc: 180 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM. Polyester: 0.1 μ f ±10%, 50 VDCW. Silver mica: 270 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15. Polyester: 0.1 µf ±10%, 50 VDCW. Ceramic disc: 1000 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF. Polyester: 0.22 μ f ±10%, 50 VDCW. Ceramic disc: 1000 pf $\pm 20\%,$ 1000 VDCW; sim to RMC Type JF. Earlier than REV J: Ceramic disc: 470 pf $\pm 20\%,$ 1000 VDCW; sim to RMC Type JF. Polyester: 0.047 µf ±20%, 50 VDCW. Polyester: 0.22 µf ±10%, 50 VDCW. Earlier than REV C: Ceramic disc: 0.1 μf +80% -20%, 12 VDCW; sim to Sprague 20C202. Polyester: 0.15 μ f ±20%, 50 VDCW. Earlier than REV C: Polyester: 0.1 μ f ±20%, 50 VDCW. Polyester: 0.1 μ f ±20%, 50 VDCW. Polyester: 0.22 μf ±10%, 50 VDCW. Electrolytic: 5 µf +75% -10%, 6 VDCW; sim to Sprague Type 30D. Ceramic disc: 2000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF. Deleted by REV C. Tantalum: 47 μf ±20%, 6 VDCW; sim to Sprague Type 150D. Polyester: 0.047 μ f ±20%, 50 VDCW. Earlier than REV C: Polyester: .068 µf ±20%, 50 VDCW.

LBI-3757

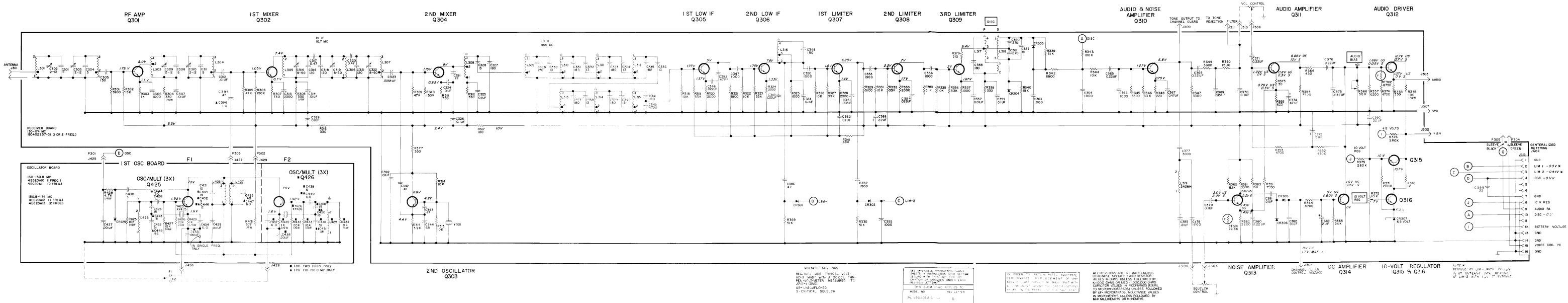


VE (-) TO GND	POSITIVE (+) PROBE TO GND
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	1.8K
G OHM	60 K
<u>с онм</u>	60 K
G OHMS	6.8K
)	IΩ (HI)
)	8Ω(LO)
(150K

TO REMOVE RECEIVER AND OSCILLATOR BOARDS FROM SHIELD REMOVE SCREWS SHOWN BY ARROWS. ALSO DISCONNECT GREEN AND BLACK SLEEVED INLINE CONNECTORS BEHIND



ALTERNATE FOR L317 & L318.



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SCHEMATIC DIAGRAM

132-174 MHz RECEIVER TYPE ER-52-A 19R620717, Rev. 31 $\mathbf{21}$ LBI-3757

57 SYME	OL GE PA	PART NO.	DESCRIPTION	SYMBOL	ge part no.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION		GE PART NO.	DESCRIPTION
C376			Polyester: 0.22 $\mu f \pm 10^{\prime_{p}}$, 50 VDCW.	1.303*	19B204402G3	Coil Assembly. In Models earlier than REV E:			RESISTORS	R 352 and R353	3R77P472K	Composition: 4700 ohms $\pm 10\%$, 1/2 w.	C426	5496219 P 244	Ceramic disc: 15 pf $\pm 5\%,$ 500 VDCW, temp coest -80 PPM.	C449*	5496219P37	Ceramic disc: 6 pf ±0.25 pf 0 PPM,
C377	549448		Ceramic disc: 3000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF.		19B204402G2	Coil Assembly.	R301 R302	3R77P392K 3R77P153K	Composition: 3900 ohms ±104, 1/2 w. Composition: 15,000 ohms ±104, 1/2 w.	R354*	3R77P332K	Composition: 3300 ohms ±10%, 1/4 w,	C427	7491393P1	Ceramic disc: .001 μf +100% -0%, 500 VDCW; \leqslant_{sim} to Sprague 1219C4.			In Models of REV B and earlie
C378	549448		Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW: sim to RMC Type JF.	L304	19B204402G3	Coil Assembly.	R303	3R77P102K	Composition: 1000 ohms $\pm 10\%$, $1/2$ w.			In Models earlier than REV C:	C428	5496219 P 37	Ceramic disc: 6 pf ± 0.25 pf, 500 VDCW, temp.		5496219P39	Ceramic disc: 8 pf ±0.25 pf 0 PPM.
C379	749182		Ceramic disc: 0.1 μ f +80% -30%, 50 VDCW; sim to Sprague 36C172.	L305 and	19B204403G1	Coil Assembly.	R304	3R152P331K	Composition: 330 ohms $\pm 10\%$, 1/2 w.		3R152P222K	Composition: 2200 ohms $\pm 10\%$, $1/4$ w.	C429*	5494481P112	coef 0 PPM. Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim tro	C450	5496219P245	Ceramic disc: 18 pf ±5%, 500
C380	19A116		Polyester: 0.22 µf ±10%, 50 VDCW,	L306 L307	19B204403G2	Coll Arrestly	R305	3R77P473K	Composition: 47,000 ohms $\pm 10\%$, 1/2 w.	R355*	3R77P621J	Composition: 620 ohms $\pm 5\%$, $1/2$ w.	0125	54544617112	RMC Type JF Discap.	C451	5496219P257	-80 PPM. Ceramic disc: 56 pf ±5%, 500
C381*	19A116	.6080P1	Polyester: 0.01 μ f ±20%, 50 VDCW.	L307	19820440362 19A115711P1	Coil Assembly. Transformer, freq: 455 KHz: sim to Automatic	R306	3R77P154K	Composition: 0.15 megohm $\pm 10\%$, 1/2 w.		3R152P431J	In Models earlier than REV C: Composition: 430 ohms ±5%, 1/4 w.		7491393P1	In Models of REV B and earlier:			-80 PPM.
			Earlier than REV E:	thru L315*		Mfg EX12670.	R307 R308	3R77P751J 3R152P331K	Composition: 750 ohms ±5%, 1/2 w. Composition: 330 ohms ±10%, 1/4 w.	R356	3R77P431J	Composition: 430 ohms ±5%, 1/4 w.		749139391	Ceramic disc: .001 μf +100% -0%, 500 VDCW; \approx_{sim} to Sprague Type 1219C4.			DIODES AND RECT
	749182		Ceramic disc: .01 μf +80% -30%, 50 VDCW: sim to Sprague 19C180.		19C303062G6	Earlier than REV L: Coil Assembly. Includes tuning slug 4038368P1.	R309	3R77P473K	Composition: 47,000 ohms $\pm 10\%$, 1/2 w.	R357	3R77P622J	Composition: 6200 ohms $\pm 5\%$, 1/2 w.	C430	5496219P34	Ceramic disc: 3 pf ± 0.25 pf, 500 VDCW, temp coef 0 PPM.	CR425	4038056P1	Germanium.
C382	19A116	6080P107	Polyester: 0.1 μ f $\pm 10\%$, 50 VDCW.	L316*	19A115711P2	Transformer, freq: 455 KHz: sim to Automatic	R310	3R77P154K	Composition: 0.15 megohm $\pm 10\%$, 1/2 w.	R358	3R77P331K	Composition: 330 ohms $\pm 10\%$, 1/2 w.	C431	5496219P241	Ceramic disc: 10 pf ± 0.25 pf, 500 VDCW, tem _{$k_2 coef ~80$ PPM.}			JACKS AND RECEP
C383	549567		Electrolytic: 2 μ f +75% -10%, 25 VDCW; sim to Sprague 30D.			Mfg EX12671.	R311	3R77P751J	Composition: 750 ohms $\pm 5\%$, 1/2 w.	R359*	3R152P104J	Composition: 0.1 megohm $\pm 5\%, \ 1/4$ w. Deleted by REV E.	C432	5496219 P 240	Ceramic disc: 9 pf ± 0.25 pf, 500 VDCW, temp.	J425 thru	4033513P4	Contact, electrical: sim to
C384	19A116	.6080P107	Polyester: 0.1 μ f ±10%, 50 VDCW.		19C303062G6	Earlier than REV L: Coil Assembly. Includes tuning slug 4038368P1.	R312 R313	3R77P331K	Composition: 330 ohms $\pm 10\%$, 1/2 w.	R360*	3R77P823J	Composition: 82,000 ohms $\pm 5\%$, 1/2 w.	a 100		coef -80 PPM.	J429		
C385	19A116	.6080P201	Polyester: 0.01 $\mu f \pm 5\%$, 50 VDCW.	L317*	19A115711P6	Transformer, freq: 455 KHz: sim to TOKO PEFCN-	and R314	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.			In Models earlier than REV E:	C433*	5494481P112	Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim \pm_0 RMC Type JF Discap.	L425	19A121085G1	INDUCTORS
C386	549620	203P117	Ceramic disc: 47 pf $\pm 10\%$, 500 VDCW, temp coef -3300 PPM.			14733-CX12.	R315	3R77P392K	Composition: 3900 ohms $\pm 10\%$, $1/2$ w.	R361	3R152P753J	Composition: 75,000 ohms $\pm 5\%$, 1/4 w.			In Models of REV B and earlier:	L426	19A121083G1	Coil Assembly. Includes tuni Coil Assembly. Includes tuni
C387	549621		Ceramic disc: 51 pf ±5%, 500 VDCW, temp coef -470 PPM.		19C303062G4	Earlier than REV L: Coil Assembly. Includes tuning slug 4038368P1.	R316	3R77P331K	Composition: 330 ohms $\pm 10\%$, $1/2$ w.	R362	3R77P332J 3R77P222J	Composition: 3300 ohms ±5%, 1/2 w. Composition: 2200 ohms ±5%, 1/2 w.		7491393P1	Ceramic disc: .001 µf +100% -0%, 500 VDCW; sim to Sprague 1219C4.	L427	19A121083G1	Coil Assembly. Includes tuni
C388	549626		-470 FFm. Tantalum: 22 μf ±20%, 15 VDCW; sim to	L318*	19A115711P7	Transformer, freq: 455 KHz; sim to TOKO PEFCN-	R317	3R77P101K	Composition: 100 ohms $\pm 10\%$, 1/2 w.	R363	3R77P153J	Composition: 15,000 ohms ±5%, 1/2 w.	C434*	5496219 P 37	Ceramic disc: 6 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.	L428	19A121085G1	Coil Assembly. Includes tuni
60.00			Sprague Type 150D.			14734-BNL2.	R318	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.	R364	3R77P472K	Composition: 4700 ohms $\pm 10\%$, $1/2$ w.			In Models of REV B and earlier:		1	
C389 C390	19A116 549626		Polyester: 0.1 μ f ±20%, 50 VDCW.		19C303062G5	Earlier than REV L: Coil Assembly. Includes tuning slug 4038368P1.	R319 R320	3R77P333K 3R77P202J	Composition: 33,000 ohms $\pm 10\%$, $1/2$ w.	R365	3R77P243J	Composition: 2400 ohms $\pm 5\%$, 1/2 w.		5496219P34	Ceramic disc: 3 pf ±0.25 pf, 500 VDCW, temp coef	Q425*	19A115925P1	Silicon, NPN,
			Tantalum: 22 μf $\pm 20\%,$ 15 VDCW: sim to Sprague Type 150D.	L319	5491736P2	Inductor: 240 mh $\pm 10\%$ ind at 0.5 v, 270 ohms	R320	3R77P512J	Composition: 2000 ohms ±5%, 1/2 w. Composition: 5100 ohms ±5%, 1/2 w.	R366*	19B209358P108	Variable, carbon film: approx 100 to 50,000 ohms $\pm 10\%$, 0.25 w; sim to CTS Type X-201.	C435*	5496219P235	0 PPM. Ceramic disc: 4 pf ±0.25 pf, 500 VDCW, temp coef	and Q426*		To Mad 2 - Diana and a second
C391	549000		Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.			max DC res; sim to Aladdin 33-161.	R322	3R77P103K	Composition: 10,000 ohms $\pm 0\%$, 1/2 w.			Earlier than REV L:	0100	0 100 2101 200	-80 PPM.		19A115342P1	In Models earlier than REV B: Silicon, NPN.
C392*	19A116	6080P1	Polyester: .01 μf $\pm 20\%$, 50 VDCW.			PLUGS	R323	3R77P333K	Composition: 33,000 ohms $\pm 10\%$, $1/2$ w.		19B204808G1	Resistor Assembly. Includes resistor, variable, carbon film: $50,000$ ohms $\pm 20\%$, 0.1 w.		F 4020300000	In Models earlier than REV A:			STREEN, NFR.
			Earlier than REV F:	P301 thru	4029840P2	Contact, electrical: sim to Amp 42827-2.	R324	3R77P202J	Composition: 2000 ohms $\pm 5\%$, 1/2 w.	R369	3R77P513J	Composition: 51,000 ohms ±5%, 1/2 w.		5496219P236	Ceramic disc: 5 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.	R425	2015001001	RESISTORS
	749182		Ceramic disc: .01 μf +80% -30%, 50 VDCW: sim to Sprague 19C180.	P303 P304	7147199P1		R325	3R77P102K	Composition: 1000 ohms $\pm 10\%$, 1/2 w.	R370	3R77P102J	Composition: 1000 ohms $\pm 5\%$, 1/2 w.	C436*	7130348P1	Molded, phen: 0.47 pf \pm .047 pf. 500 VDCW, tepp coef 0 PPM; sim to Jeffers Type JM-5/32. Delieted		3R152P103K 3R152P203J	Composition: 10,000 ohms ±10 Composition: 20,000 ohms ±10
C393	549621		Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef -150 PPM.	and P305	/14/19991	Connector: 1 male contact; sim to Winchester Electronics 21803.	R326 R327	3R77P103K 3R77P333K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w.	R371	3R77P202J	Composition: 2000 ohms $\pm 5\%$, $1/2$ w.	0105	- 40 (01 0 0 0 0	by REV A.	R427	3R152P103K	Composition: 10,000 ohms ±10
C394*	713034		-150 PPM. Molded, phen: 0.47 pf ±.047 pf, 500 VDCW, temp				R328	3R77P202J	Composition: 33,000 ohms ±10%, 1/2 w. Composition: 2000 ohms ±5%, 1/2 w.	R372*	19B209358P106	Variable, carbon film: approx 75 to 10,000 ohms $\pm 10\%$, 0.25 w; sim to CTS Type X-201.	C437*	5496219 P 37	Ceramic disc: 6 pf ± 0.25 pf, 500 VDCW, temp coef 0 PPM.	R428	3R152P472K	Composition: 4700 ohms ±10%,
C395*			coef 0 PPM. Added by REV B.	Q301	19A115342P1	Silicon, NPN.	R329	3R77P512J	Composition: 5100 ohms ±5%, 1/2 w.			Earlier than REV L:			In Models of REV B and earlier:	R429 and	3R152P102K	Composition: 1000 ohms $\pm 10\%$,
0393*	748916		Mica: 22 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15. Added by REV B.	Q302			R330	3R77P513J	Composition: 51,000 ohms ± 5 %, $1/2$ w.		19B204808G2	Resistor Assembly. Includes resistor, variable,		5496219P34	Ceramic disc: 3 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.	R430		
C396*	713034		Molded, phen: 1 pf \pm ,05%, 500 VDCW, temp coef 0 PPM. Added by REV B.	Q303	19A115889P1	Silicon, NPN: sim to Type 2N2712.	R331	3R77P103K	Composition: 10,000 ohms $\pm 10\%$, $1/2$ w.	R373	3R77P300J	carbon film: .01 megohm ±20%, 0.1 w. Composition: 30 ohms ±5%, 1/2 w.	C438*	5494481P112	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim tto	R431 R432	3R152P331K	Composition: 330 ohms ±10%,
C397*	748916	62P139	Silver mica: 330 pf $\pm 10\%$, 500 VDCW; sim to	Q304	19A115342P1	Silicon, NPN.	R332	3R77P333K	Composition: 33,000 ohms $\pm 10\%$, $1/2$ w.	R374	3R77P472J	Composition: 4700 ohms $\pm 5\%$, 1/2 w.			RMC Type JF Discap. In Models of REV B and earlier:	R432 R433	3R152P203J 3R152P103K	Composition: 20,000 ohms ±5% Composition: 10,000 ohms ±10
			Electro Motive Type DM-15. Added by REV D. Deleted by REV M.	Q305* and Q306*	19A116774PI	Silicon, NPN: sim to Type 2N5210.	R333 R335	3R77P202J 3R77P103K	Composition: 2000 ohms $\pm 5\%$, $1/2$ w.	R375 and	19A116278P444	Metal film: 0.28 megohm $\pm 2\%$, 1/2 w.		7491393P1	Ceramic disc: .001 µf +100% -0%, 500 VDCW; ssim	and R434		
			DIODES AND RECTIFIERS			In REV R and earlier:	R336	3R77P333K	Composition: 10,000 ohms $\pm 10\%$, 1/2 w. Composition: 33,000 ohms $\pm 10\%$, 1/2 w.	R376			C439	5496219 P 37	to Sprague 1219C4.			Sockets
CR301	403805		Germanium.	020.7	19A115889P1	Silicon, NPN; sim to Type 2N2712,	R337	3R77P102J	Composition: 1000 ohms ±5%, 1/2 w.	R377	3R77P331K	Composition: 330 ohms $\pm 10\%$, $1/2$ w.	0105	0100210101	Ceramic disc: 6 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.	XY425 and	5490277P1	Transistor: 4 contact, low-1 phenolic: sim to Elco 3303.
and CR302				Q307 thru Q309	19A115889P1	Silicon, NPN: sim to Type 2N2712.	R338	3R77P331K	Composition: 330 ohms $\pm 10\%$, 1/2 w.	R378 R379*	3R152P101K 3R152P511J	Composition: 100 ohms $\pm 10\%$, 1/4 w.	C440	5496219P244	Ceramic disc: 15 pf $\pm 5\%$, 500 VDCW, temp coelf -80 PPM.	XY426		phenorre, sim to rico 5303.
CR303 and	19A115	5250P1	Silicon.	Q310*	19A116774P1	Silicon. NPN; sim to Type 2N5210.	R339 and	3R77P513J	Composition: 51,000 ohms $\pm 5\%$, 1/2 w.			Composition: 510 ohms $\pm 5\%$, $1/4$ w. Added by by REV N.	C441	5496219P56	Ceramic disc: 51 pf ±5%, 500 VDCW, temp coeß 0 PPM.		the second second second	CRYSTALS
CR304	100005					In REV N and earlier:	R340 R341	0.01.7.000.000		R380*	3R152P512J	Composition: 5100 ohms $\pm 5\%, \ 1/4$ w. Added by REV M.	C442	5496219P257	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coeff			NOTE: When reordering give G specify exact freq needed.
CR305 and CR306	403805	56PI 0	Germanium.		19A115123P1	Silicon, NPN; sim to Type 2N2712.	R341 R342	3R152P681K 3R77P682K	Composition: 680 ohms $\pm 10\%$, 1/4 w.	R 381 *	3R152P472J	Composition: 4700 ohms $\pm 5\%$, 1/4 w. Added by REV R. Deleted by REV S.			-80 PPM.			Crystal Freq = (OF -10.7 MHz)
CR307	403688	87P6	Silicon, Zener.	Q311*	19A116755P1	Silicon, NPN; sim to Type 2N3947.	R343	3R77P104K	Composition: 6800 ohms $\pm 10\%$, $1/2$ w. Composition: 0.1 megohm $\pm 10\%$, $1/2$ w.			Detected by nEV 5.	C443	5496219P245	Ceramic disc: 18 pf ±5%, 500 VDCW, temp coet -80 PPM.	¥425 and ¥426	19B206221P1	Quartz: freq range 39 to 62
CR308			Silicon, Zener. Deleted by REV M.		19A115123P1	In REV R and earlier:	R344*	3R77P103J	Composition: 10,000 ohms ±5%, 1/2 w.	RT301	5400000000		C444*	5496219P37	Ceramic disc: 6 pf ±0.25 pf, 500 VDCW, temp coef -0 PPM.	1120		
			JACKS AND RECEPTACLES	Q312	19A115300P4	Silicon, NPN; sim to Type 2N2712. Silicon, NPN; sim to Type 2N3053.			In REV R and earlier:	R1301	5490828P29	Rod: 0.228 megohm $\pm 5\%$ res at 25°C, 1 w max input at 40°C; sim to Globar 723B-1.			In Models of REV B and earlier:			
J 301	549607		Receptacle, coaxial: sim to FXR 27-3.	Q313*	19A116774P1	Silicon, NPN; sim to Type 2N5210.		3R77P153K	Composition: 15,000 ohms $\pm 10\%$, 1/2 w.	RT302	5490828P28	Rod: 8750 ohms $\pm 5\%$ res at 25°C, 1 w max input at 40°C; sim to Globar 723F-2.		5496219P39	Ceramic disc: 8 pf ±0.25 pf, 500 VDCW, temp coef -0 PPM.			
J302	403351		Contact, electrical: sim to Bead Chain L93-3.			In REV N and earlier:	R345 R346	3R77P332K	Composition: 3300 ohms $\pm 10\%$, 1/2 w.				C445	5496219P244	Ceramic disc: 15 pf ±5%, 500 VDCW, temp coeft			
J311					19A115123P1	Silicon, NPN: sim to Type 2N2712.	R340	3R77P333K 3R77P332K	Composition: 33,000 ohms $\pm 10\%$, 1/2 w.	¥301	19A110215G1		and C446		-80 PPM.			
J312	19B205	5689G2	Connector: 18 contacts.	Q314*	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R348	3R77P221K	Composition: 3300 ohms ±10%, 1/2 w. Composition: 220 ohms ±10%, 1/2 w.				C447*	5496219P237	Ceramic disc: 6 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.			
			INDUCTORS		19A115123P1	In REV R and earlier:	R349	3R77P332J	Composition: 3300 ohms ±5%, 1/2 w.			FIRST OSCILLATOR ASSEMBLY MODELS 4EG20A1013			-so PPM. In Models earlier than REV A:			
L301	19B204	4402G4	Coil Assembly.	Q315	19A115123P1 19A115300P2	Silicon, NPN: sim to Type 2N2712. Silicon, NPN: sim to Type 2N3053.	R350	3R77P152J	Composition: 1500 ohms $\pm 5\%$, 1/2 w.			19D402259G3 - Single Freq 132-150.8 MHz 19D402259G4 - Two Freq 132-150.8 MHz 19D402259G1 - Single Freq 150.8-174 MHz		5496219P238	Ceramic disc: 7 pf ±0.25 pf, 500 VDCW, temp coef			
L302	19B204	4402G1	Coil Assembly.	Q316*	19A116755P1	Silicon, NPN: sim to Type 2N3947.	R351	3R77P752J	Composition: 7500 ohms $\pm 5\%$, $1/2$ w.			19D402259G2 - Two Freq 150.8-174 MHz	C448*	7130348P3	-80 PPM. Molded, phen: 1 pf \pm .05 pf, 500 VDCW, temp e_{0} ef			
						In REV R and earlier:						CAPACITORS	0.10	. 1000 1050	0 PPM; sim to Jeffers Type JM-5/32. Deleted by REV A.			
					19A115123P1	Silicon, NPN: sim to Type 2N2712.				C425	5496219P56	Ceramic disc: 51 pf $\pm 5\%$, 500 VDCW, temp coef 0 PPM.						
				hereite		· · · · · · · · · · · · · · · · · · ·		L				•				J L	L	1

PTION

25 pf, 500 VDCW, temp coef

earlier:

25 pf, 500 VDCW, temp coef

, 500 VDCW, temp coef

%, 500 VDCW, temp coef

D RECTIFIERS - - - - -

RECEPTACLES - - - - - im to Bead Chain L93-3.

s tuning slug 19B200497P2. s tuning slug 19B200497P2. s tuning slug 19B200497P2. s tuning slug 19B200497P2.

REV B:

ns ±10%, 1∕4 w. s ±10%, 1∕4 w. ms ±10%, 1/4 w. ±10%, 1/4 w. ±10%, 1/4 w.

±10%, 1/4 w. .ms ±5%, 1/4 w. ms ±107, 1/4 w.

Æтs – – – – – – – – – low-loss mica-filled 303.

give GE Part Number and

7 MHz) ÷ 3. to 62 MHz.

PRODUCTION CHANGES

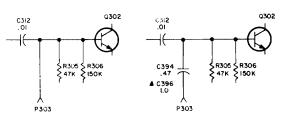
Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

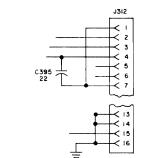
Was

REV. A (19D402257-Gl only) - To match voice coil hi and ground of J312 to G-E Test Set 4EX3A10. Moved VOICE COIL HI from J312-7 to J312-15. Moved GND from J312-15 to J312-7. REV. B (19D402257-G1 only) - To improve systems spurious. Added C394, C395, C396, ground lug under mounting screw of J312, and jumper between ground lug and J312-16.

Elementary Diagram C anges

Changed to

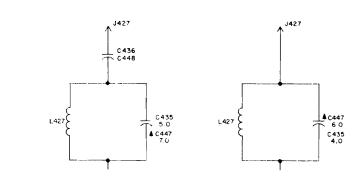




REV. C (19D402257-GJ only) - To improve audio response characteristics. Changed C368, C369, C375, R354 and R355. Deleted C373 from collector to base of Q311.

REV. A (4EG20A10-13 only) - To improve systems spurious. Deleted C436 and C448, and changed C435 and C447.

Elementary Diagram Changes Was Changed to



REV. D (19P402257-G1 only) - To reduce squelch clipping at high signal levels. Added C397.

REV. E (19D402257-Gl only) - To prevent squelch changes with temperature and to reduce gain of RF Amplifier. Changed C306, C313, C357. C381, L303 and R360. Deleted R359.

REV. F (19D402257-Gl only) - To improve temperature stability. Changed C324 and C392.

REV. G (19D402257-Gl only)	- To minimize the affect of line voltage transients on receiver operation. Added R378,
REV. B (4EG20A10-13)	- To imcorporate an improved transistor. Changed Q425 and Q426.
REV. C (4EG20A10-13)	- To prevent free-running of the oscilla- tor without a crystal. Changed C429, C433 and C438,
REV. H (19D402257-G1)	- To improve 1st Mixer stability. Changed C313.
REV. J (19D402257-G1	- To eliminate 450 kHz from the squelch circuit and lower maximum squelch opening level.
REV. K (19D402257-G1)	- To provide improved bypass capacitors in low IF circuit. Changed C346, C349, C351 and C354.
REV. L (19D402257-G1)	- To facilitate manufacturing and procure- ment of parts. Changed L308-L318, R366, and R372.
REV. M (19D402257-G1)	- To prevent squelch lock-up at high signal levels. Deleted C397. Changed CR308.
REV. N (19D402257-G1)	- To improve discriminator idling and tuning. Added R379.
REV. P (19D402257-G1)	- To increase maximum squelch opening level. Changed the following:
	C328 C336 Q310 C330 C338 Q313 C332 C340 C334
REV. R (19D402257-G1)	- To improve squelch clipping, Added R381,
REV. S (19D402257-G1)	- To improve squelch clipping and to in- comporate new transistors Changed 0305

To improve squelch clipping and to in-corporate new transistors. Changed Q305, Q306, Q311, Q314 and Q316 and changed R344. Deleted R381.

STEP I - QUICK CHECKS

SYMPTOM	PROCEDURE
NO SUPPLY VOLTAGE	Check power connections and continuity of supply leads, and check fuse in power supply. If fuse is blown, check recei- ver for short circuits.
NO REGULATED 10 VOLTS	Check the 12-volt supply. Then check regulator Q315 and regulator circuit. Resistance reading of 10-volt supply from the emitter of Q315 to ground should be 2 K ohms.
LOW 2ND LIM READING	Check supply voltages and then check oscillator reading at J312-4 as shown in STEP 2A. Make SIMPLIFIED VTVM GAIN CHECKS from 2nd Mixer through 2nd Limiter stages as shown in STEP 2A.
LOW OSCILLATOR READING	Check alignment of Oscillator (Refer to Front End Align- ment Procedure). Check voltage and resistance reading of Oscillator Q425. Check crystal Y425.
LOW RECEIVER SENSITIVITY	Check Front End Alignment (Refer to Receiver Alignment Procedure). Check antenna connections Check voltage and resistance readings of RF Amp and 1st and 2nd Mixers. Make SIMPLIFIED GAIN CHECKS (STEP 2A).
LOW AUDIO	 Check Audio PA (Q701) output current at J312-9. If reading is low a. Check BIAS ADJ for 0.25 VDC at J312-9 (STEP 2A). b. Check Q701. Make SIMPLIFIED GAIN and WAVEFORM CHECKS (STEPS 2A and 2B) of Audio and Squelch stages. Check unsquelched voltage readings in Audio section (Refer to Receiver Schematic Diagram). Check voltage and resistance readings on Channel Guard receiver.
IMPROPER SQUELCH OPERATION	Make GAIN and WAVEFORM CHECKS (STEPS 2A and 2B) of Audio and Squelch stages. Check voltage and resistance readings of Squelch circuit (Refer to Receiver Schematic Diagram).
DISCRIMINATOR IDLING TOO FAR OFF ZERO	See if discriminator zero is in the center of IF bandpass.

STEP 3- GAIN-PER-STAGE READINGS-



- I. RF VOLTMETER (SIMILIAR TO BOONTON MODEL 91-CA OR MILLIVAC TYPE MV-18 C.
- SIGNAL ON RECEIVER FREQUENCY (BELOW SATURATION) CORRECT FREQUENCY CAN BE DETERMINED BY ZEROING THE DISCRIMINATOR.

PROCEDURE

- I. APPLY PROBE TO INPUT OF STAGE (FOR EXAMPLE, BASE OF RF AMP). PEAK RESONANT CIRCUIT OF STAGE BEING MEASURED AND TAKE VOLTAGE READING (E₁).
- MOVE PROBE TO INPUT OF FOLLOWING STAGE (IST.MIXER ₩). REPEAK FIRST RESONANT CIRCUIT THEN PEAK CIRCUIT BEING MEASURED AND TAKE READING (E₂).
- CONVERT READINGS (BY SUBTRACTING E FROM E ON THE DB SCALE OF RF VOLTMETER, OR) BY MEANS OF THE FOLLOWING FORMULA.

AMP FACTOR

- CHECK RESULTS WITH TYPICAL GAINS SHOWN ON DIAGRAM BELOW.
- 5. USE PROCEDURE LISTED ABOVE TO FIND GAIN OF EACH STAGE.

★ NOTE: REMOVE CRYSTAL OR SHORT OUT OSC. BASE BEFORE MEASURING MIXER STAGES TO ELIMINATE INJECTION VOLTAGE.

STEP 2A- SIMPLIFIED VTVM GAIN CHECKS

EQUIPMENT REQUIRED :

I. VTVM-AC&DC

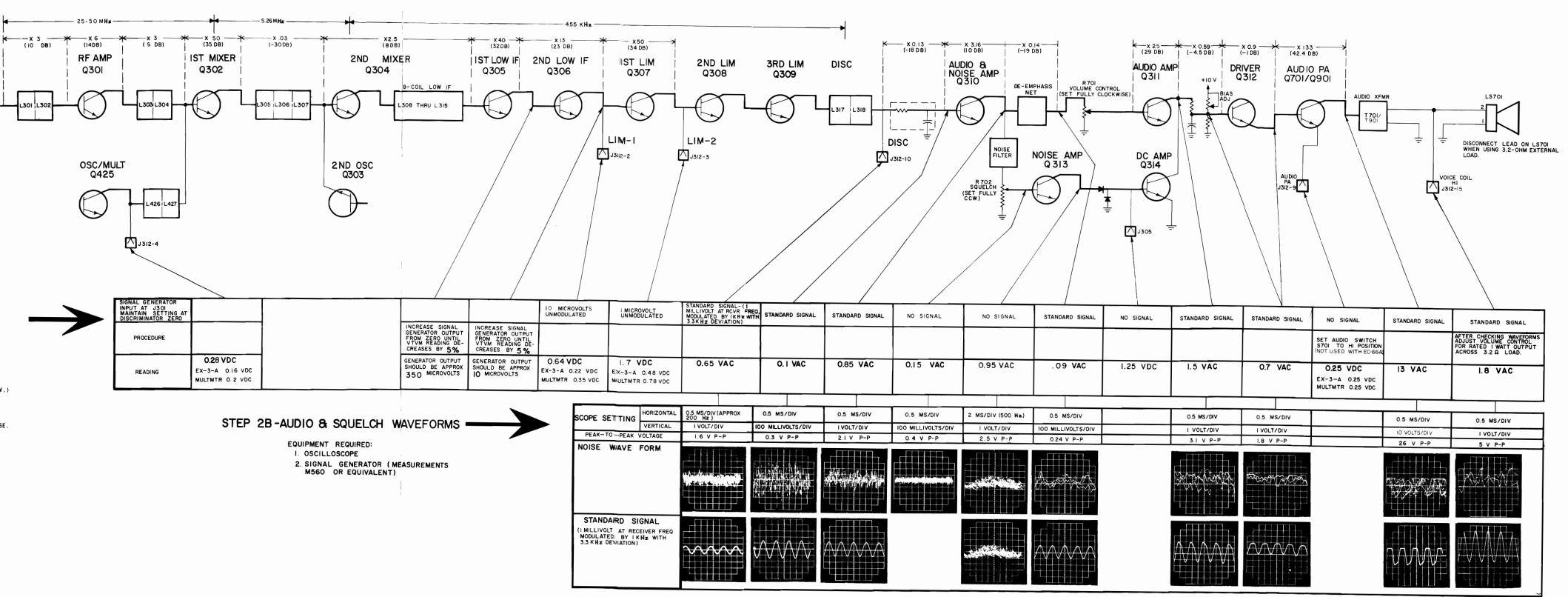
2. SIGNAL GENERATOR (MEASUREMENTS M560 EQUIV.)

PRELIMINARY STEPS:

I. SET VOLUME CONTROL FULLY CLOCKWISE.

2. SET SQUELCH CONTROL FULLY COUNTERCLOCKWISE.

3. RECEIVER SHOULD BE PROPERLY ALIGNED.



TROUBLESHOOTING PROCEDURE

25-50 MHz RECEIVER TYPE ER-51-A

RC-1482A

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SYMPTOM	PROCEDURE
NO SUPPLY VOLTAGE	Check power connections and continuity of supply leads, and check fuse in power supply. If fuse is blown, check recei- ver for short circuits.
NO REGULATED 10 VOLTS	Check the 12-volt supply. Then check regulator Q315 and regulator circuit. Resistance reading of 10-volt supply from the emitter of
LOW 2ND LIM READING	Q315 to ground should be 2 K ohms. Check supply voltages and then check oscillator reading at J312-4 as shown in STEP 2A.
	Make SIMPLIFIED VTVM GAIN CHECKS from 2nd Mixer through 2nd Limiter stages as shown in STEP 2A.
LOW OSCILLATOR READING	Check alignment of Oscillator (Refer to Front End Alignment Procedure).
	Check voltage and resistance reading of Oscillator Q425.
	Check crystal Y425. (substitution method)
LOW RECEIVER SENSITIVITY	Check Front End Alignment (Refer to Receiver Alignment Procedure).
	Check antenna connections.
	Check voltage and resistance readings of RF Amp and 1st and 2nd Mixers.
	Make SIMPLIFIED GAIN CHECKS (STEP 2A).
LOW AUDIO	Check Audio PA (Q701) output current at J312-9. If reading is low
	a. Check BIAS ADJ for 0.25 VDC at J312-9 (STEP 2A).
	b. Check Q701.
	Make SIMPLIFIED GAIN and WAVEFORM CHECKS (STEPS 2A and 2B) of Audio and Squelch stages.
	Check unsquelched voltage readings in Audio section (Refer to Receiver Schematic Diagram).
	Check voltage and resistance readings on Channel Guard receiver.
IMPROPER SQUELCH OPERATION	Make GAIN and WAVEFORM CHECKS (STEPS 2A and 2B) of Audio and Squelch stages.
	Check voltage and resistance readings of Squelch circuit (Refer to Receiver Schematic Diagram).
DISCRIMINATOR IDLING TOO FAR OFF ZERO	See if discriminator zero is in the center of IF bandpass.

STEP 3- GAIN-PER-STAGE **READINGS-**

EQUIPMENT REQUIRED:

- I. RF VOLTMETER (SIMILIAR TO BOONTON MODEL 91-CA OR MILLIVAC TYPE MV-18 C.
- SIGNAL ON RECEIVER FREQUENCY (BELOW SATURATION) CORRECT FREQUENCY CAN BE DETERMINED BY ZEROING THE DISCRIMINATOR.

PROCEDURE

- I. APPLY PROBE TO INPUT OF STAGE (FOR EXAMPLE, BASE OF RF AMP). PEAK RESONANT CIRCUIT OF STAGE BEING MEASURED AND TAKE VOLTAGE READING (E₁).
- MOVE PROBE TO INPUT OF FOLLOWING STAGE (IST.MIXER 30. REPEAK FIRST RESONANT CIRCUIT THEN PEAK CIRCUIT BEING MEASURED AND TAKE READING (E2).
- 3. CONVERT READINGS (BY SUBTRACTING E, FROM E₂ ON THE DB SCALE OF RF VOLTMETER, OR) BY MEANS OF THE FOLLOWING FORMULA.

AMP FACTOR

- CHECK RESULTS WITH TYPICAL GAINS SHOWN ON DIAGRAM BELOW.
- 5. USE PROCEDURE LISTED ABOVE TO FIND GAIN OF EACH STAGE.

* NOTE: REMOVE CRYSTAL OR SHORT OUT OSC. BASE BEFORE MEASURING MIXER STAGES TO ELIMINATE INJECTION

STEP 2A- SIMPLIFIED VTVM GAIN CHECKS

EQUIPMENT REQUIRED:

I. VTVM-AC&DC

2. SIGNAL GENERATOR (MEASUREMENTS M560 EQUIV.) PRELIMINARY STEPS:

I. SET VOLUME CONTROL FULLY CLOCKWISE.

2. SET SQUELCH CONTROL FULLY COUNTERCLOCKWISE.

3. RECEIVER SHOULD BE PROPERLY ALIGNED.

TROUBLESHOOTING PROCEDURE

132—174 MHz RECEIVER TYPE ER-52-A

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RC-1483A

END OF DOCUMENT

